V-2. Comprehensive Promotion Programmes for the Computers & Computer Peripherals Industry

V-2-1. Basic Strategy

Based on the analysis and evaluation of the computers & computer peripherals industry in Malaysia and the international environment surrounding them, and in view of the feasibility of and potential for their quick development, it has been concluded that the promotion of foreign investment is the most important element for the development of the industry. Measures to promote foreign investment are expected to have a beneficial impact on the existing industry as well as related industries.

The basic strategy for the development of the industries can be summarized as follows.

Basic Strategy for the Development of the Computers & Computer Peripherals Industry

- In light of the current situation of the computers & computer peripherals market and technology therein, the invitation of foreign investment is crucial if Malaysia's computers & computer peripherals industry are to be developed at a rapid pace. Thus the first priority of a development policy should be measures to promote foreign investment.
- 2. Specifically, measures should be considered to (1) strengthen activities to promote foreign investment and (2) improve the production environment. In view of the broader possibilities for investment in Malaysia and the far-reaching impact it would have on industry as a whole, a wide range of manufacturers, including related parts manufacturers, should be covered by measures for the promotion of foreign investment.
- 3. In terms of the improvement of the production environment, targets should include (1) development of human resources and (2) a higher ratio of local sourcing of components. In the area of human resource development, it is necessary to improve training of supervisors, skilled workers and engineers, particularly in design. For the development of the components industry, efforts must be made to improve technology, marketing and quality control.
- 4. It is necessary to create a more encouraging environment for R&D to reverse the current trend toward insufficient R&D activities at the level of domestic private firms, to accumulate original technologies and to develop human resources through the strengthening of R&D activities by government organizations.

V-2-2. Proposed Comprehensive Promotion Programmes

Based on the outcome of the study and what is assumed to be the most realistic scenario for development, a series of measures to realise the development of the computers & computer peripherals industry in Malaysia are proposed. The process of formulation of the comprehensive programmes is shown in Fig. V. 2-1. Summaries of the measures are presented below in the outline of each programme.

The proposed execution measures and implementation schedules of these programmes are summarized and shown in Table V. 2-1.

Programme 1. Intensification of the Investment Promotion Organization's Activities

(Objective)

* To intensify investment promotion activities aimed at foreign computers & computer peripherals manufacturers and related components manufacturers, the organisation will make recommendations to each of the other government organisations concerned with regard to the improvement of the domestic investment environment.

(Contents)

- * Dispatch of investment promotion missions to overseas computers & computer peripherals manufacturers, holding of seminars and invitation of missions comprising potential investors
- * Preparation and supply of specific information regarding the industry and related areas
- * Collection of industrial information and implementation of surveys to discover promising potential investors
- * Matching of domestic firms which are interested in entering the industry with foreign firms which are interested in technical tie-up agreements or OEM contracts
- * Identification of the present status and needs of industries and planning for more effective industry support, human resource development, and so forth through the establishment of an industry association concerning electronics.

Programme 2. Strengthening of Measures for the Development of Small and Medium Scale Manufacturing Enterprises

(Objective)

* Strengthening of the competitiveness of domestically produced products and improvement of the investment environment though the development of supporting industries

(Contents)

- 1) Establishment of a policy making committee in relation to the development of supporting industries
- * Identification of the present status of supporting industries and clarification of areas to be developed and measures for development
- * Adjustment of supporting measures implemented by Ministries and organisations
- 2) Strengthening of support for development and improvement of products/production processes
- * Establishment of an assistance fund for the development and improvement of products/production processes
- * Implementation of services to dispatch experts and consultants
- 3) Strengthening of support for higher quality
- * Formulation of incentives for guidance and other supports for parts suppliers from assembly manufacturers (contractors)
- * Establishment of an inspection system for quality improvement of domestically produced components
- 4) Strengthening of support for market expansion
- * Expansion of MTI's subcontracting schemes and strengthening of public relations activities
- * Strengthening of incentives for the promotion of use of domestically produced components

Programme 3. Intensification of Export Promotion Activities

(Objective)

* Strengthening of support for market expansion for local part manufacturers to promote supporting industries.

(Contents)

- * Intensification of business through preparation of a directory of Malaysia's supporting manufacturers
 - Or, integration of the directory and MTI's subcontracting schemes. In this case, the directory will be prepared and updated every year using a database prepared under the subcontracting scheme
- * Financial support for participation in overseas electronics shows or other exhibitions, or, supply of exhibition booths free of charge
- * Invitation of overseas purchasing missions and sponsorship of exhibitions
- * Re-energizing of inquiry services handled by MEXPO

Programme 4. Promotion of QC Activities

(Objective)

* To strengthen the competitiveness of domestically produced products and to improve the level of supporting industries through the widespread use of concepts and tools for quality control. Targets should not be limited to specific companies and industries. Through public relations activities, the programme should be made available to any firm wishing to introduce QC activities

(Contents)

- * Preparation and supply of QC manuals by NPC and industrial associations
- * Increasing of the number of QC seminars and QC classes by NPC
- * Training of management staff overseas through NPC, which functions as a
- * Guidance through visits to factories in small & medium-scale industries

Programme 5. Strengthening of Training of Skilled Workers

(Objective)

* To improve the level of supporting industries and the investment environment through solutions to the lack of skilled workers, one of the serious problems facing the entire electronics industry

(Contents)

- 1) Expansion of vocational training schools
- * Increasing the supply of skilled workers through the expansion of training courses in metal processing, an area which has a far-reaching impact on

- industry as a whole and which is now suffering from a serious shortage of skilled workers
- * Renewal of curricula and expansion of training courses in the areas of electronics engineering and electrical engineering where the supply of skilled workers is insufficient
- 2) Establishment of government-industry technical training institutions
- * Examination of the possibility of establishing government-industry technical training institutions for employees in several regions where many electronics manufacturers are located with the aim of establishing a system to more effectively respond to the industry's needs with regard to human resources. The following two types of technical centres may be considered.
 - i) Expansion of manufacturers' in-house training programmes and reception of employees from other manufacturers. The government would offer incentives for this type of training center. The programme would be worked out based on similar programmes which have already been undertaken by several manufacturers in Singapore
 - ii) The government would supply land, buildings and operating funds while companies would be responsible for the supply of equipment and experts. The specific operations would be examined by a committee including representatives of the both the government and private sector
- 3) Opening of short-term training centers for employees by NPC and CIAST
- * Opening of seminars for supervisor class people at NPC. The seminars would involve general curricula relating to production process management and training
 - In some cases, organization of overseas study missions
- * Facilitation of a technically high level of training through the expansion of CIAST
- 4) Establishment of seminars and consulting services for managers of medium and small-scale firms
- * Holding of seminars for managers of medium and small-scale firms by NPC for the purpose of convincing them of the necessity of training employees
- * Provision of consulting services for firms which require planning or creation of a system for the introduction of training courses
- 5) Review of incentives for in-house training programmes
- * Review and clarification of standards in response to comments that it is difficult to meet the standards under the current incentive measures

Programme 6. Training of Electronics-related Engineers and Intensification of R&D Activities

(Objective)

* To invigorate R&D activities which are currently not very widespread in Malaysia. In addition, to train engineers to meet the expected needs of the computer industry

(Contents)

- 1) Expansion of electronics curricula at universities
- * Increasing of the number of graduates from electronics courses and information processing departments
- * Review of curricula of electronics departments
- 2) Strengthening of MIMOS activities
- * Setting up of schemes to dispatch staff to related organizations overseas or to universities overseas for study
- * Establishment of a system to invite foreign experts for R&D project under MIMOS.
- * Reception of technical trainees from private firms
- * Formulation of a medium and long-term plan by MIMOS with regard to the creation of a framework and development objectives, taking into consideration industries which Malaysia will promote in the coming years. In addition, increasing of the number of staff members and budget.
- 3) Widespread computer-related education
- * Promotion of installation of P/Cs at junior high schools and high schools (under implementation)
- * Setting up of INTAN computer training center with training courses for teachers engaged in computer education
- 4) Realization of the transfer of Technology Park and expansion of incentives for firms to locate in the park
- * Realization pending transfer plan and improvement of environment of the park
- * Examination of expansion of incentives for firms to locate in the park Creation of opportunities for people in charge to visit similar kinds of facilities overseas and to exchange views with foreign counterparts
- 5) Review of current R&D incentives
- * Review and clarification of the standards, taking into consideration comments that it is difficult to meet the standards under the current incentive measures

- * Examination of a more intensive incentive scheme including provision of subsidies to industries which specifically require development measures
- * Encouraging firms experiencing bottlenecks in terms of facilities, equipment and human resources to launch joint studies with universities and MIMOS Offering of financing for joint studies to universities and MIMOS
- 6) Expansion of scholarship scheme for study at foreign universities or institutes
- * Increasing the number of students in universities' electronics-related departments under the current Look-East Scholarship Scheme

Programme 7. Expansion of Low Interest Rate Loan Scheme to Promote Supporting Industries

(Objective)

* The promotion of the computer industry requires the augmentation of the supporting industries. In particular, development of the metalworking and plastic injection molding industries would be desirable. In these industrial fields, there has already been some degree of growth of local companies and domestic demand may be expected to increase, so these are fields in which growth should be possible centered on the local companies.

In these industries, a major decisive factor in whether production is possible or not is the introduction of equipment, in the same way as knowhow. The small and medium sized companies, in particular local companies which cannot expect any support from a parent company, often have trouble in raising funds. Development can be promoted by providing loans to these companies under

(Contents)

The following two cases may be considered as methods of use of the existing schemes for low interest rate loans:

initial investment and introduction of equipment.

1) Projects in supporting industries where local capital is involved should be covered by the AJDF loans without setting any limits as to size of capital.

more advantageous terms of interest and repayment periods than usual for their

- 2) The long-term low interest rate industrial loans such as the New Investment Fund (NIF) offered in the past and of excellent reputation should be resumed for small and medium sized companies.
 - Further, consideration is given to the establishment of a new fund for promotion of supporting industries.

Fig. V. 2-1 Process of Formulation of Comprehensive Programmes for Development of Computers and Computer Peripherals Industry

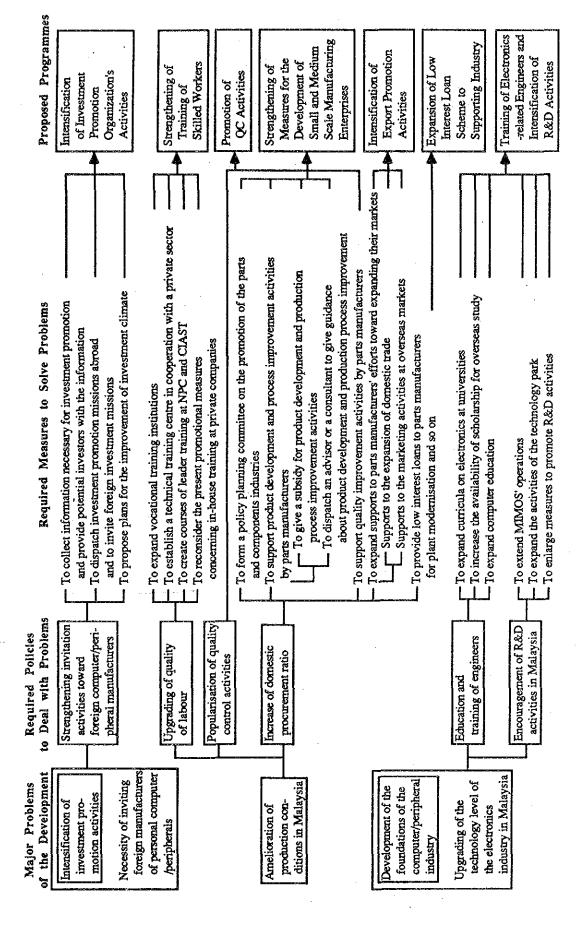


Table V. 2-1 Execution Measures and Schedules of the Proposed Programmes (Computers and Computer Peripherals Industry)

			Execution measures and their schedules	and their	schedule	
Name of the programme and its	Contents of the programme	Measures to be taken		Execu	Execution schedules	lules
objectives		by Malaysian side	Measures	Imme- diately	At an early date	After prepa- ration
I. Intensification of Investment Promotion Activities (Expansion of MIDA Activities) Objectives> Promotion of foreign investment in Malaysia Promotion of technical tie-ups between foreign and Malaysian manufacturers 	Information service for invitation of foreign investment Compilation of guidebooks for each industry sector Preparation of a directory of domestic parts suppliers 2) Dispatch of investment invitation missions	 Collection of industry-specific information Strengthening of linkages between MIDA and the MTI Small and Medium Industry Division Creation of PDT teams for dis- 	Preparation of guidebooks	0 0	u de puede de la media de la colonia del la colonia de la	
	3) Strengthening of accommodation facilities for receiving investment missions 4) Matching of firms desiring tieups ups	patch overseas - Strengthening of receiving facilities by industry and country - Listing of firms desiring tie- ups	Invitation of foreign experts Ad-hoc cooperation	0 0		······································
2. Development Programme for Small and Medium-scale Manufacturers <objectives> - Formulation of policies for the development of supporting industries and the coordination of activities at related organizations for that purpose - Visits to SMIs by experts for guidance in the areas of production technology, management, and marketing skills</objectives>	1) Help for individual SMIs in improving production technology with the cooperation of foreign experts and staff from the MTI Small and Medium Scale Enterprises Unit, SIRIM, and other related organizations 2) Help for individual SMIs in improving management and marketing skills with the cooperation of foreign experts and staff from the MTI Small and Medium Industry Division, NPC, and	- Expansion of the MTI Small and Medium Scale Enterprises Unit - Appointment of instructors at SIRIM, etc. for touring guidance to individual companies - Appointment of instructors at NPC, MEXPO, etc. for touring guidance to individual companies inies	Invitation of foreign experts in production technology Invitation of foreign experts in management and marketing Invitation of foreign experts in SMI policy	0 0 0		

			Execution measures and their schedules	and their	schedule	S
Name of the programe and its	Contents of the programme	Measures to be taken		Execu	Execution schedules	dules
objectives		by Malaysian side	Measures	Imme- diately	At an early date	After prepa- ration
·	MEXPO 3) Creation of a policy and coordination section within the MTI Small and Medium Industry Division for coordination of the above activities and formulation of comprehensive policies for the development of SMIs					
3. Intensification of Export Promotion Activities (Expansion of MEXPO Activities) - Support for the domestic and overseas marketing efforts of local parts manufacturers as part of the activities for development of supporting industries incoment of supporting industries	Strengthening of MEXPO capabilities for the collection and distribution of marketing-related information Strengthening of the inquiry service Preparation of a directory of local parts manufacturers Timely distribution of information to local companies Invitation of foreign purchasing missions and sponsoring of exhibitions	- Expansion of MEXPO staff and budget	Information collection Reception of missions from abroad Dispatch of missions	0 00		
4. Promotion of Quality Control Activities <objectives> - Raising quality awareness</objectives>	1) Invitation of quality control experts under the sponsorship of NPC and industry associations for the following activities:	 Greater support for NPC activities Greater support for industry association activities 	Invitation of foreign quality control experts Overseas training		00	

	lules	After prepa- ration	, , , , , , , , , , , , , , , , , , ,	
schedules	Execution schedules	At an early date		
and their	Execu	Imme- diately		0 0 0
Execution measures and their schedules		Measures		Invitation of foreign experts Overseas training Invitation of foreign experts Overseas training
	Measures to be taken	by Malaysian side		- Preparation of estimates of current curriculae, instructors, and facilities together with plans for expansion - Creation of a committee to investigate related matters - Observation of similar facilities in other countries - Reexamination of existing incentives
	Contents of the programme		- Holding of seminars on quality control - Holding of quality control workshops at individual companies 2) Compilation of quality control manuals and distribution to local companies	1) Expansion of vocational training schools, MARA, etc. - Enlargement of metal machining courses at the above institutions - Enlargement of electronics and electrical machinery engineering courses at the same 2) Creation of a joint public-private technical training center - Investigation of a joint technical training center such as the ones in Singapore and Thailand 3) More active in-house training in the private sector
	Name of the programme and its	objectives	among these firms for the development of the local parts industry Improving quality and productivity of exports by more active quality control efforts at plants	5. Strengthening of Training of Skilled workers <objectives> Resolution of the shortage of skilled labourers plaguing the electronics industry, improved standards in peripheral indus- tries, and improvements in the quality of the investment envi- ronment</objectives>

Name of the programe and its Objectives 6. Human Resources Development and R&D Expansion in the Fielf cation at the university level and of Electronics Objectives Training of engineers required by the electronic industry Promotion of R&D activities by national research institutes Texpansion of Financing 1) Support for private-sector R&D through electronics-related education and experience between industry and academia Promotion of R&D activities Promotion of the USM Design Laboratory for Information Technology Scheme Promotion of the USM Engines of the USM Engineers of the USM E	<u> </u>		and meir	Execution measures and their schedules	
	mme Measures to be taken		Execut	Execution schedules	iules
(1) (2) (1)	by Malaysian side	Measures	Imme- diately	At an early date	After prepa-
1	- Promotion of the USM Design Laboratory for Information Technology Scheme - Promotion of the UKM Engineering Application Centre Scheme - Enlargement of the MIMOS staff and budget - Creation of a system for the overseas training of staff and the invitation of foreign experts	Invitation of foreign experts Introduction of facilities Invitation of foreign experts Introduction of facilities Introduction of facilities Invitation of foreign experts Overseas training		0 00 00 0	
	- Investigation and study on a new investment/financing sys- tem	Overseas training Invitation of foreign ex- perts	0	0	

V-2-3. Review of Priority Programmes

To develop the selected industries, it would be ideal if all of the comprehensive programmes proposed for the industry were quickly implemented with full effort. However, given the reality of the very tight limitations on both financial and human resources, it is necessary to give a rough priority ranking to each proposed programme.

Because sufficient feasibility studies were not possible for all of the programmes proposed in this study, a priority ranking of each programme could not be given using strict criteria such as IRR (Internal Rate of Return) figures for each programme. As an alternative, a priority ranking for each programme was determined through the rather subjective judgement of the Study Team which considered the same basic criteria as used in section V-1-3. The results of an examination of priorities are shown in Table V. 2-2.

The selected priority programmes for the computers and computer peripherals industry, described in Table V.2-2, were integrated into the programmes for the electronics-related industries, and then final priority projects were proposed as the result of compiling Three Years' Comprehensive Programmes covering all the industries.

Among them priority projects related to the computers and computer peripherals industry are as follows.

- 1) Intensification of Investment Promotion Activities in MIDA
- 2) Programme for Reinforcement of Human Resources Development
- 3) Technical Support Project for Small and Medium Scale Manufacturers

Details regarding the above 3 priority projects are given in the Section III-5. of the separate Report, "Total Review of the Three Years' Studies".

Table V. 2-2 Results of Priority Programme Identification (Computers and Computer Peripherals Industry)

	Intensification of Investment Promotion Activities (Expansion of MIDA Activities)	Programme for Small and Medium Intensification of Scale Manufacturing Export Promotion Quality Control Enterprises Activities	Intensification of Export Promotion Activities	Promotion of Quality Control Activities	Strengthening of Training of Skilled Workers	Human Resources Development and R&D Expansion in the Field of Electronics	Financing Scheme for Development of Supporting Industries
Existence of established organizations in charge of the programme	Yes (MIDA)	Yes (MTI)	Yes (MEXPO)	Yes (NPC)	Yes (Vocational training school, MARA, etc.)	Yes (MIMOS, USM, UKM and others)	No
2. Maturity level of the programme	High (presently being supported)	High (plan already exist)	High (presently being supported)	Low	Moderate	Moderate (in planning stage)	Low
3. Urgency of the needs of the programme	High	High	Moderate	Ľow	High	Moderate	Moderate
4. Scale of investment in the programme	Medium	Medium	Medium	Small	Medium	Large	Large
5. Level of direct impact	Great	Great	Moderate	Moderate	Moderate	Moderate	Moderate
6. Necessity of outside assistance	Moderate	Strong	Moderate	Weak	Strong	Moderate	Moderate
Priority selection	«	¥	В	В	Ą	g	д

Note: A: The programme is selected as a priority programme B: The programme is given a secondary importance

ANNEX

I Member Lists of Steering Committee and Technical Committee

Member List of the Steering Committe (November 3,1989)

Attendance from the Malaysian Side

Dr. Abdullah Mohd Tahir (Chairman) Director of Industry Section Economic Planning Unit (EPU) Prime Minister's Department

Mr. Abdul Malek Abdul Khalid

Ministry of Trade and Industry

(ITM)

Mr. Ramli Mahmud

MT I

Mrs. Rusiah Mohamed

MEXPO, MTI

Mr. Wee Ton Wang

Malaysian Industrial Development Authority (MIDA)

Mrs. Foong Jit Cheng

MIDA

Mr. Abdul Halim Abdul Rahman

Standard and Industrial Research Institute of Malaysia (SIRIM)

Mr. Mohamad Rafee Yusoff

Malaysian Institute of Microelectronics System (MIMOS)

Miss Yap Kim Lian

EPU (Manpower Section)

Mr. Fakhrurazi Abdul Majid

EPU (Industry Section)

Mrs. Zawiah Chik

EPU (Macro Section)

Mr. Allauddin Hj. Anuar

EPU (Industry Section)

(Secretary)

Attendance from the Japanese Side

Mr. Heihachiro AOKI

Leader of the Study Team

Mr. Toshio ASAKURA

Deputy Leader of the Study Team

Mr. Takashi NOBEHARA

Deputy Leader of the Study Team

Mr. Shunichi HAMADA

Embassy of Japan

Mr. Sadahiro SUGITA

Embassy of Japan

Mr. Kuniaki NAGATA

JICA Malaysia Office

Mr. Koichi HAYASE

JICA Expert (MIDA)

Member List of the Technical Committe (December 11,1989)

Attendance from the Malaysian Side

Mr. J. Jegathesan Director

(Chairman) Industrial Promotion Division, MIDA

Mr. Abdul Halim Abdul Rahman SIRIM

Mrs. Rusiah Mohamed MEXPO

Mr. Zulkifli Rauf MTI

Mr. Megat Ahmad Zaki SIRIM

Dr. Arif Nun MIMOS

Mr. Chua Eng Seng MIDA

Mr. Wee Ton Wang MIDA

Mr. N. Parameswaran MIDA

Mr. Kamarulzaman Othman MIDA

Attendance from the Japanese Side

Mr. Heihachiro Aoki Leader of the Study Team

Mr. Toshio Asakura Deputy Leader of the Study Team

Mr. Takashi Nobehara Deputy Leader of the Study Team

Mr. Yoshitsugu Matsumoto JICA Study Team

Mr. Toshiaki Endo JICA Study Team

Miss Junko Sekiguchi JICA Study Team

Mr. Koichi Hayase JICA Expert (MIDA)

II Castings

II-1 List of Companies and Organizations Visited

II Castings

${\rm I\hspace{-.1em}I}-1$ List of Companies and Organizations Visited

(1) Factories

	Name of Company	Address	<u>Tel.</u>
1.	See Seng Foundry Works	Section 92 & 92A Lot No. 3	7821350
		3 1/2 Miles, Jalan Sungai Besi	
		57100 Kuala Lumpur	
2.	Kwan Cheong Engineering	312 Jalan Sungai Besi	2215612
	(1976) Sdn Bhd	57100 Kuala Lumpur	
3.	Dah Yung Steel (M)	19 Jalan Empat	2213166
	Sdn Bhd	Off Jalan Chan Sow Lin	
	•	55200 Kuala Lumpur	
4.	Hung Chang Machine	134B Jalan Chan Sow Lin	2215514
	Moulding Sdn Bhd	55200 Kuala Lumpur	
5.	Lianyeu Manufacturing	62 Jalan Kilang Midah	9719064
	Sdn Bhd	Jalan Ceras	
		56000 Kuala Lumpur	
6.	Alloy Art Sdn Bhd	No. 56E, Jalan Enam	2211154
		Off Jalan Chan Sow Lin	
		55200 Kuala Lumpur	
7.	United Casting Sdn Bhd	Lot 27 Jalan 3A Kawasan	9052136
		Perusahaan Balakong	
		Taman Ceras Jaya	
		43200 Ceras, Selangor	
8.	Automated Engineering	No. 33 1st Floor	7924300
	Products Sdn Bhd	(A) Jalan 4/47	
	•	46050 Petaling Jaya	

9.	Soon Fatt Engineering	194A 17th Miles	6916901
	Works	Jalan Ipoh	
•		48000 Rawang, Selangor	
10.	Gah Hup Seng Sdn Bhd	Batu 6 Jalan Tg Karang	8795812
		45500 Tg Karang	÷
		Selangor Darul Ehsan	
11.	Anshin Casting	Jalan Gergaji 15/14	5502888
	Industries Sdn Bhd	40000 Shah Alam	
		Selangor	
12.	Sin Soon Hoe Foundry	3 3/4 Miles Jalan Kapar	3911645
	Engineering Works	41400 Klang, Selangor	
13.	Yodoshi Malleable (M)	Lot 97 Ayer Keroh Industrial	3252000
	Sdn Bhd	Estate, Ayer Keroh	
		75450 Melaka	
14.	Kinko Steel Mill Bhd	Tanjong Agas Industrial Area	922473
		P.O. Box 24	
		84007 Muar, Johor	
15.	Sapura Automotive	Lot 98 Kawasan Perindustrian	324092
	Industries Sdn Bhd	Air Keroh, Jalan Úsaha 7	·
		75450 Melaka	
16.	Matsushita Electric Co	Shah Alam Industrial Site	5591010
	(M) Bhd	40000 Shah Alam	
17.	Matsushita Industrial	No. 2 Jalan SS 8/1	7761788
	Corp Sdn Bhd	Sungei Way Free Trade Zone	
		P.O. Box 1012	
		Jalan Semangat	
		46766 Petaling Jaya	

18.	Hicom Diecastings Sdn Bhd	Tingkat 19, Menara Dato' Onn Kompleks UMNO 45 Jalan Tun Ismail Peti Surat 10707 50722 Kuala Lumpur	2935688
19.	International Diecastings Sdn Bhd	No. 14 Jalan Tandang 46050 Petaling Jaya	7912180
20.	Yoonsteel (Malaysia) Sdn Bhd	Site 14 Tasek Road Tasek Industrial Estate 31400 ipoh	551700
21.	Tasek Iron & Steel Foundry Sdn Bhd	Lot 24 Tasek Industrial Estate 31400 Ipoh	551264
22.	Yau Fong Foundry Sdn Bhd	Lahat Road Falim, 30200 Ipoh	545477
23.	Sin Tong Fatt Foundry	465 Bemban New Village 31000 Batu Gajah Perak	381358
24.	Sun Kong Luen Cheong Foundry Sdn Bhd	Siputeh Road Pusing, Perak	381177
25.	Menglembu Wahcheong Foundry Sdn Bhd	2 3/4 Miles, Ipoh Road 31450 Menglembu Ipoh	542745
26.	Teak Heng Foundry Sdn Bhd	Lot 39A, 2nd Mile, Ipoh Rd 31450 Menglembu, Perak	547262

27. Hup Ngai Loong Foundry Sdn Bhd	1409 Lahat Road 31450 Menlembu Perak	542406
28. Butterworth Foundry	29762 Siram Road Butterworth Province Wellesley	346345
29. Chin Wool Foundry	342 Jalan Semagagah 13500 Permatang, Pauh	301085
30. Selangor Pewter Marketing Sdn Bhd	4 Jalan Usahawan Enam Setapak Jaya 53200 Kuala Lumpur	4238 136
31. Selberan Co Sdn Bhd	6 Jalan Perusahaan Kiri Setapak, 53200 Kuala Lumpur	4231158
32. Lien Yaik Hardware (M) Sdn Bhd	411-W, Batu 4 Jalan Ipoh 51200 Kuala Lumpur	2215550
(2) Pattern maker		
1. Chan Wei Wooden Ware Factory	310 Jalan Sungai Besi 57100 Kuala Lumpur	2214235
(3) Material dealers		·
1. Lian Aik	411W Batu 4 Jalan Ipoh 51200 Kuala Lumpur	2215550
2. Lim Kow & Sons Sdn Bhd	75-1B Main Street Kipong 52000 Kuala Lumpur	6342773

1.	Sumitomo Corporation	15th Floor, UBN Tower	2
	•	10 Jalan P Tamlee	
		50710 Kuala Lumpur	
2.	Yah Chew Services Pte Ltd	3B Jalan Foo Yet Kai	
		30300 Ipoh, Perak	
(5) l	lsers		
1.	Perusahaan Otombil	Hicom Industrial Estate	5
	National Sdn Bhd	Baru 3, Locked Bas No. 12	
		40990 Shah Alam	
2.	Hicom-Yamaha Mfr.	Hicom Industrial Estate	5
	Malaysia Sdn Bhd	Batu Tiga, 40000 Shah Alam	
(6) I	Related organizations	·	
1.	Malaysian Industrial	Wisma Damansara	2
	Development Authority	Damansara Heights	
	(MIDA)	P.O. Box 10618	
		50720 Kuala Lumpur	
2.	Standards & Industrial	Section 2, P.O. Box 35	5
	Research Institute	40700 Shah Alam	
	of Malaysia (SIRIM)		
3.	Centre for	Section 19, P.O. Box 12	5
	Instructor and Advanced	40700 Shah Alam	

4.	Perak State Development Corporation	Bahagian Industri Tingkat 2, Wisma Wan Mohd Jalan Kelab 30904 Ipoh	503666
5.	Institut Kemahiran MARA	Jalan Belangkas Kampong Pandan 55100 Kuala Lumpur	9844455
6.	Selangor Foundry & Engineering Industries Association	8 (1st Floor) Jalan 1-77B Off Jalan Changkat Thambi Dollah, Kuala Lumpur	2483461
7.	Perak Foundry & Engineering Industries Association	No. 79 (1st Floor) Jalan Sultan Idris Shah 30000 Ipoh	549824
8.	Penang Foundry & Engineering Industries Association	No. 229-B Jalan Jelutong 11600 Penang	375736

II-2 Questionnaire Sheet for Survey in Malaysia

QUESTIONNAIRE SHEET

THE STUDY ON SELECTED INDUSTRIAL PRODUCT DEVELOPMENT IN MALAYSIA

(FOR FOUNDRY INDUSTRY)

OCTOBER, 1989

PREPARED BY:

JAPAN INTERNATIONAL COOPERATION AGENCY
IN COOPERATION WITH
MALAYSIAN INDUSTRIAL DEVELOPMENT AUTHORITY

DIRECTION FOR USE

- 1. Please tick in □ wherever is appropriate.
- 2. Please fill in as much informations as possible.
- 3. Only approx. volumes and values are needed.
- 4. Questionnaire completed and returned to us are used only for our survey and are not made public.
- 5. Please photostat one set of the completed questionnaire for your own keeping.
- 6. Please return the completed questionnaire to "MIDA Office".

QUESTIONNAIRE CONTENTS

Α.	COMPANY OUTLINE	3
В.	PRODUCTION	4
	1. products	4
	2. Machinery	5
	3. Manufacturing	7
	4. Materials	1 0
	5. Quality Control	
	6. Local sub-contracting	1 3
c.	SALES	1 4
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D.	LABOUR MANAGEMENT	1 6
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F.	TECHNICAL TIE-UPS/JOINT VENTURES	2 2
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A. COMPANY OUTLINE

1.	Name of Company	•
	& Address	
		•
	Tel	: Fax :
2.	Name of Chief Executive	`
3.	Name of Responsible	: Name
	Person for Contact	: Designation
4.	Year of Establishment	•
5.	Paid-up Capital	: <u>M\$</u>
	Shareholders: Malaysian	: <u>M\$</u>
	: Foreign	: <u>M\$</u> (Investor:)
6.	Main Bank	•
7.	Legal status	Family business/single proprietorship Partnership Company Cooperative Joint venture with foreign firms Government company Foreign owned
8.	Land & Factory Area (1) Foundry : L	and <u>m²</u> Factory <u>m²</u>
	(2) Total : L	and <u>m²</u> Factory <u>m²</u>
9.	Main Production Items (1) Foundry:	
	(2) Others :	
10.	Annual Sales Turnover (1988) & Number of Employees (at the end of the year)
	Ann	ual sales (M\$1,000) Number of Employees
	(1) Foundry	
	(2) Others	
	Total	

B. PRODUCTION

1. Products

(1) Production Volume & Capacity

m	1988 (tons	Main Products	
Type of casting	Production volume	Capacity	Main Froducts
• Gray iron			
• Ductile iron		,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	
• Malleable iron			
• Carbon steel			
Alloy steel			
• Copper alloy			
• Aluminum alloy			
• Die casting			
• Lost wax casting		,	
• Others			
Total			

(2) Production ratio by User Industry

User Industry	ratio(%)
1. Rubber Industry	
2. Tin Industry	
3. Palm Oil Industry	
4. Timber Industry	
5. Building Material Industry	
6. Automobile Industry	
7. Motorcycle Industry	
8. Railway Industry	***************************************
9. Agriculture Machinery Industry	***************************************
10. Marine Industry	
11. Electrical Equipment Industry	
12. Other Machinery Industry	
13. Other	
Total	100%

(3)	Maximum	weight	of	one	piece	and	number	of	lot

Weight	Number of lot
☐ Less than 10 kgs ☐ 11 — 100 kgs ☐ 101 — 500 kgs ☐ 501 — 1000 kgs ☐ More than 1 tons (max. tons)	☐ Less than 10 pieces ☐ 11— 50 ☐ More than 51

	(4)	Tolerance	of	main	product
--	-----	-----------	----	------	---------

100 mm or	rough	estimate
10 mm		
1 mm		
1/10 mm		
1/100 mm		
Less than	1/100	mm

2. Machinery

(1) Manufacturing Equipment & Machinery (only estimate of years of use)

Name of	Num	bers in	use (un	Planning to (unit) install within			
Machinery & Equipment	Total	under 3years	3-10 years	over 10year	under 1 year	1-3 years	over 3years
1) Patterning Machines Lathe, Wood works							
Planer, Wood works							
Sawing Machine, Band saw/Cir.							
Drilling Machine							
Router							
Sander							
Surface Plate							
2) Melting Furnace Cupola							
Low Frequency Furnace							.,,,,
High Frequency Furnace						-	
Arc Furnace							
Crucible Furnace							

					· · · · · · · · · · · · · · · · · · ·		
3) Sand Treatment Simpson type Sand Mill		**************		***************	***************************************		
Sand Mixer, Screw/Rotter Type							
Sand Blender		************		*****************		.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,	
Sand Recycling Equipment							
4) Moulding Jolt Moulding Machine		*************			***************************************	***************************************	
Jolt Squeeze Moulding Machine							
Core Blowing Machine							
Shell Moulding Machine							
Shell Core Blowing Machine			•••••				
Sand Slinger Stationary/Motive							
Die Casting Machine					***************************************		
Centrifugal Moulding Machine		i					
5) Fettling Machine Shake out Machine							
Shot Blasting Machine							
Turn Blasting Machine							
Swing Grinder							*************
Grinding Machine							
6) Welding Machine Welding Machine							
Carbon Arc Blasting							
7) Heat Treatment Furnace							
8) Testing and analyzer_							
Chemical Analysis Equipment		.,.,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,,			**********		
Tensile Strength Tester		.,				 	
Brinell Hardness Tester	***************************************						
Shore Hardness Tester							
Optical Pyrometer							
Temperature Record Meter							
Carbon Equivalent Meter							
Total							

(2) Main Facility (Melting)					
1) Cupola				·	
 a) Type Simple design type, withou Conventional standard type Hot blast type Oxygen rich type Others (please specify) 	ı	Type A (<u>Cupola</u>	Type B Cupola	
b) Capacity			<u>t/h</u>	t/h	
c) Unit				<u></u>	
2) High or Low Frequency Induction F	urnace				
a) Power	Type A Fce.	•	Type B Fce	1	
• Electric Power:	kw			kw_	
• Transformer :	kva			(va_	
b) Caspacity	t/batch	-	t/ba		
c) Unit	57,550	•			
3) Crucible Furnace	Type A Fce.		Type B Fce	,	
a) Capacity	kgkg			kg	
b) Unit		= -			
3. Manufacturing					
(1) Sand Casting Process					
•					
1) Pattern shop □ None □ Have (How many workers : _			_)		
2) Who plans the gating system (cast Worker themselves Engineer / Manager Pattern maker Supply from customers	ing plan)				
3) Who plans the charging materials Worker themselves Engineer / Manager Others (please specify):			ng		
4) Moulding Sand					
a) Kinds m • Natural • Natural synthetic • Synthetic • Others (please specify)	ould core)
 b) Reclaimed sand Dust control method Using Not using 					
5) Moulding process	ld core				
• Green sand process • CO ₂ process • Shell mould process • Cement process • Others (please specify)	Id core)	

6) Mouldin	ng method Hand moulding Machine moulding		Flask moulding Flaskless moulding Pit moulding	
(2) Die Casti	ng Process			
1) Product	ion of mould In-House Outsource			
2) Melting	Furnace Reverberatory (Capacity Others (Capacity	y) y)	t X	(number)
3) Holding	Furnace Electric Others			
4) Pouring	Equipment Manual Mechanical			
* 30t * 31- * 51- * 101	50t X			
6) Pick up	method of product Manual Mechanical			
(3) Lost Wax	Process			
1) Pressu	re injectied into mould 7 to 14 kgf/cm² 50 kgf/cm² 140 kgf/cm²			
2) Wax ma	terial Pure wax Mixed wax with plastics			
3) Cerami	c shell mould			·
a) Bin C C C	der for slurry] Coloidal silica] Ethylsilicate] Hybrid			
b) Siu	rry and stucco] Zircon] Soluble silica] Soluble alumina			
•	ting operation Number of coating Thickness of coating	nur thi	nber ickness <u>nu</u>	
d) Dew C C	l Autoclave			
e) Bak	ing Temperature Time		* C 	

4) Pouring Gravity Pressure Vacuum Centrifugal C L A		
5) Finishing Caustic soda soluble heated by Autoclave	° C	
(4) Sources of technical information Newspaper Magazine (Local) Magazine (Foreign) Seminar Workshop Exhibition Consultant Extension officer Circular Corporative Industrial Sevice Institute Human network Subcontractor Other firms University/college	SIRIM (MIDEC) MEXPO NPC CIAST MISIF FOMFEIA Others (Please specify) (:	
(5) Casting defects		
1) Defects phenomenum Blow hole Pin hole Sand inclusion Slag inclusion Misrun Shrinkage Crack Chill Others (please specify) (:	,	
2) Reject percentage		
• Iron casting	%	
Malleable casting	%	
• Steel casting	<u> </u>	
• Cu alloy casting	%	
• Al alloy casting	%	
• Die casting	%	
• Lost wax casting	%	
• Others	%	

4. Materials

(1) Procurement & Price Level

	Su	Supplied by			Price Level		
Materials	Self	Local	lmport	Major import country	1988	1989	
	-				* M\$/ t	M \$/t	
Pig iron		П					
Iron scrap							
Steel scrap							
Cu ingot						***************************************	
Cu scrap			<u> </u>				
Al ingot							
Al scrap							
Zn ingot							
Zn scrap							
Fe - Si							
Fe - Mn							
Fe - Mo							
Fe - Cr						*****************	
Fe - Ni							
Cokes							
Silica sand							
Bentonite							
Sodium Silicate		[
Cement			<u> </u>		M\$/kg	M\$/kg	
Resin		Д					
Coal powder							
Starch							

		П	***************************************		

	П				

П					
П	П				
Д				***************************************	
	П				146.61
			ı	M\$/Kg	M\$/kg
	Д	Д	,,		
П					
atio to	Total Ma	terials	Procurement (1988)		

(2)	Import Procurement	Ratio to	Total	Materials	Procurement	(1988
	Import value	s / Total	value	s :		′%

(3) Materials quality & Procurement availability

	Quality				Procuremen	it .
Materials	Good	Fair	Bad	Easy	Normal	Difficult
Pig iron	П	П	Д	П	Д	
Iron scrap			О	_	Д	
Steel scrap					<u>D</u>	Ω
Cu insot	Д		Д		П	Д
Cu scrap				<u> </u>	Д	ш
Al ingot			Д		Д	Д
Al scrap				<u> </u>		Д
Zn ingot						
Zn scrap	<u> </u>		<u> </u>	<u> </u>		
Fe-Si				<u> </u>		
Fe-Mn		口				
Fe-Mo	О				П	Ω
Fe-Cr						Ω
Fe-Ni		Д				
Cokes						
Silica sand		Д				
Bentonite						
Sodium Silicate	Д	Д		<u> </u>		
Cement		D	П			<u> </u>
Resin			П			
Coal powder						
Starch						

5. Quality Control

No testing
In public testing institutes
In private testing institutes
In your own companies

Sand
Compression strength
Permeability
Moisture

Melting
Tapping temperature
For front test

Metal quality
Tensile strength
Hardness
Micro stracture
Chemical composition
Non-destructive test

(2) Industria	al standards in use
	BS - British Standards ANSI - American National Standards Institute ASTM - American Society for Testing and Materials SAE - Society of Automotive Engineers JIS - Japanese Industrial Standards NF - Normes Francaise ISO - International Organization for Standardization DIN - Beutshes Institut für Normung
	ry's Std. MS - Malaysian Std. TIS - Thai Industrial Std. SS - Singapore Std. NIS - Normes Indonesia Std. PS - Philippines Std.
3) Others	Customer's Std.:
	Own Std. :
(3) Your qua	ality control system
<u> </u>	No inspection system No inspection system Systematic inspections are not available, "when trouble occurs check" First articles inspection Single sampling inspection Multiple sampling inspection Sequential sampling inspection Total (100%) inspection Without acceptance or purchasing inspection With acceptance or purchasing inspection by standard inspection documents
_ _ _ _	is it inspected by? None Workers themselves Manager or the owner Professional staff, patrol Professional staff, stationary
	Visual check Sensory check Dimensional check Clearance check for moving parts Hardness check Surface roughness check Colour check X-ray check Magna flux check Noise check Life test/running test

☐ Only in fi ☐ Notice on ☐ Circulatin ☐ Establishi	g notice or inspectio ng counter measures b		anagers statistical quality control
6. Local sub-contracting	g		
(i) Major products or s specifications.	ervices made by local	sub-contractors acco	rding to your
Products or Services	Values(M\$1,000)	/yr Number of su	b-contractors
Total			
lotai			
(2) General evaluation	of local sub-contract	ing companies:	·
b) Quantityc) Deliveryd) Technical Level	: ☐ Enough ☐ : ☐ Punctual ☐	Fair Sometimes short Sometimes late Middle Fair	□ Bad □ Always short □ Always late □ Low □ Bad

c.	SALES
1.	Marketing
(1)	Sales department Have Do not have
(2)	How many staffs on sales activities?
	For local :
	For export:
(3)	Where to sell mainly your products locally?
	☐ Government ☐ Private company ☐ Others (please specity):
(4)	From where do your main competitors' products come?
	□ Local □ Foreign
(5)	Local sale expansion
	What kind of items to be expected?
	Please specify:
2.	Export
(1)	Exporting at present If no, What reasons? No more capacity Less profit Less competivive in price Less competivive in technology Complicated procedures No overseas market information Others (please specify)
(2)	Export ratio & products
F	Export ratio = Export/whole sales (1988)
	Export ratio Major export Major export Value % products country
	%

(3)	Ext	port promotic	onal activiti	es by								
			anch offices les agents sits to overs		yers							
	5)	Participation	ons in intern	ationa	l trade		over		No			
	6)	Attendances	at internati	onal t				□ otia □		or mar	ket	survey
	7)	Overseas adv	vertisement o	n Maga:	zines &	Papers						
(4)	Soi	urce of overs	seas market i	nforma	tion							
	~ `	MEXPO MISIF FOMFEIA Local tradin Tied-up over Overseas sal Overseas sta Others(pleas	ng houses rseas compani les agents yers affs se specify)		0.001	ient ient ient ient ient ient ient ient			eptableptableptableptableptableptableptableptableptableptableptableptableptableptableptabl	_		Insufficient
		:	······································									
(5)	\h	ich country's	s market info	rmatio	ns to b	e neede	d ?					
	Col	untry :	·									
					.							
(6)	Wha	at kind of ov	verseas marke	t info	rmation	s to be	need	ded f	?			
	1) 4)	Demand trend Business beh	is 2) naviour	Import 5) li	trends mport r	egulatío	3) Di ons 8	istri k res	ibutio strict	n chan íons	nel	S
	I	Please put on	aly Serial Nu	mber in	next	column i	in or	der	of im	portan	ce.	
		(i)	(ii)	(iii)		(iv)		()	ı) 			
(7)	Exp	port expansio	on									
	1)	What kind of Please speci	f items to be ify:	export	ted in	overseas	s mar	ket	?			·
	2)	Which countr Please speci	ry's market to	o be a	imed ?							

D. LABOUR MANAGEMENT

- 1. Employees
- (1) Man power composition (present) & Average wage of employees (1988)

	Employees	01.00	Factory Workers						
ltems		Staffs	* 1 Skilled workers	Semi / Unskilled workers	Total				
1) Number	Male Female								
	Total								
2) Average	employed years								
3) Average	age								
LoweUppe	onal level mary School er Secondary School er Secondary School versity / college								
5) Average	wage (M\$ / year)								

* 1 Including Supervisors

(2) Number of factory workers by casting type

	Cast iron	Malleable cast iron	Cast steel	Al,Cu alloy c.	Lost wax casting	Others	Total
Male							
Female							
Total							

2.	Operations			
	(1) Operation days :days/year	(1988)		
	(2) Operation hours : hrs/day	1 shift	;	~
		2 shift	:	~
		3 shift	:	~
3.	Training			
(1)	In-house training			
	☐ Do not do ☐ Man to man (OJT) ☐ Whenever necessary ☐ Periodically according to planned scheme ☐ Others (please specify):			

(2)	Outside t	raining						
		Do		Do not	do			
	If do, wh	ere to send yo	our e	mployees	s for t	raining	& how many ? (1988)	
		SIRIM (MIDEC)):				Private institutes	<u> </u>
		CIAST	; <u> </u>				Tied-up companies	:
		NPC	:	···			Overseas	•
		Other public institutes	:				Others	
(3)	What kind	of government	t sup	ports to	be ne	eded ?		
		Subsidy for a Expansion of Dispatch of i On-the-job to Increase of a Others (please	publ instr raini numbe	ic trair uctors f ng by fo r of tec	rom pu preign chnical	blic fac experts seminara	ilities	
4.	Morale							
(1)	Morale le	vel of employe	ees					
		Very low Relatively lo Moderate Relatively hi Very high						
(2)	QC circle	activities						
		Do		Do not	do			
					If do,	how many	y circles are there	?
						:	circles	3
(3)	Suggestion	n systems of i	mpro	ving pro	ductiv	ity & rec	ducing costs	
		Have		Do not	have			
					lf hav	e, how ma	any suggestions in a	year ?
						:	/year(1988)	<u> </u>
5.	Labour un	ion						
		Have		Do not	have			
					If hav	e, how ma	any participation ra	itio ?
						:	<u> </u>	

E. MANAGEMENT

- 1. Future production planning
- (1) Production prospects in Malaysia

Please fill in your estimates of production for castings in Malaysia.

	1988	1989	1990	1991
Volumes(1,000 tons)				

(2) \	lour-	company's	s f	uture	рJ	ann	ing
-------	-------	-----------	-----	-------	----	-----	-----

1)	Planning	to	increase	production.	(1988	production	=	100)
----	----------	----	----------	-------------	-------	------------	---	-----	---

Whithin 1 year :_______
Whithin 3 year :______
Whithin 10 year :______

2) Planning to increase export. (1988 export = 100)

Whithin 1 yea	r. :	
Whithin 3 yea	r :	
Whithin 10 ye	ar :	

2. Selling price (present)

lettille by tee (bresour)		
 Iron casting 	·	M\$/kg
 Malleable casting 	÷	M\$/kg
• Steel casting	:	<u>M\$/kg</u>
 Al alloy casting 	·	<u>M\$/kg</u>
 Cu alloy casting 	:	M\$/kg
 Die casting 	:	M\$/kg
• Lost way casting	:	M\$/kg

- 3. Manufacturing costs (present)
- (1) Cost composition

Cost		% of costs	Particulars of cost
Materials Raw materials			Costs of all materials & components for manufacturing
& Components	Others		including procured ones
Labour cost			Payroll of factory's workers & clerical staffs excluding management & sales staffs
Sub-contract cost			Cost of processing outside
Fuel & Power cost			At factory
Depreciation cost			Factory's buildings, equipment & machinery, etc.
Others			Other manufacturing costs
Total		100%	

Note: Excluding general management & sales cost and profits

	st saving Cost saving activities
	Improving productivity (reducing man-powers) Improving technology levels Procuring lower cost materials Procuring materials directly from manufacturers In-house production of materials procured outside Others (please specify):
2)	Any particular problems for reducing costs ?
	☐ Still lower production level after installing new facilities ☐ Higher cost of imported materials ☐ Higher power charges ☐ Higher fuel costs ☐ Others (please specify):
4. Fir	nancing
(1) Fu	und Raising
1)	Funds raised in the past 2 years
	AmountThousand M\$
2)	The uses fo the fund recruited in the past 2 years Increase in working capital due to the growth of sales Construction of a new plant Replacement or modernization of production facilities and equipmen Setting-up of branch offices New product development Business diversification Making-up for loss Others (please specify):
3)	The sources of funds raised in the past 2 years
	 (From Lenders in Malaysia) □ Public Financial Institutions □ Private Financial Institutions □ Private Companies and Persons □ Parent Company and Related Companies
	 (From Lenders Overseas) ☐ Financial Institutions ☐ Parent Company and Related Companies ☐ Others
4)	Funds to be recruited in the coming 2 years
	Total amountThousand M\$

	b)		Increase in working capital due to the growth of sales Construction of a new plant Replacement or modernization of production facilities and equipment Setting-up of branch offices New product development Business diversification Making-up for loss Others (please specify):
	6)	The sour	ces of funds to be recruited in the near future
			Lenders in Malaysia) Public Financial Institutions Private Financial Institutions Private Companies and Persons Parent Company and Related Companies
			Lenders Overseas) Financial Institutions Parent Company and Related Companies Others
(2)) Vs	e of the	Credit Guarantee System
	1)	Experien	nce in the use of the CGC guarantee system Using Once used, but not using now Never used
	2)		ty for the expansion of the Credit Guarnatee System in Malaysia Yes No
	3)		roblems in the present CGC system Complicated formalities Loan amount is small Severe lending condititons Additional collateral is required Eligible firms are limited only to small-scale firms We do not have enough knowledge of the system and its procedures Others (please specify):
	4)	firms in	ecessary that the government expand financial facilities for small-scale n order to improve their access to financial resources outside? Very Important Somewhat Important Not Important
5.	Rel	ocation 1	orogram .
(1)	If		at are the major reasons? The estate is limited Poor condition of procurement materials

		Poor su Poor dr Poor dr Getting Deterio Diversi Quittin Merged	pplying wate ainage situa claims of i ration of ma fication and g for public in or combin	ad condition r and electrion ndustrial pochines and electrical pochines and electrical por increase	ic power llution quipment of producti			
(2) Reloc	cation	to the F	oundry Compl	ex in future				
1) [00 you 	desire? Do Do not	do		·	· .		
2)		Near K. Near Ip Several Cheap 1	oh activities				·	
Note	The Eac	ere are c	ommon shared within the C	he Foundry C activities omplex can b	such as trai	ining, purc arate indep	hasing, mai endent mana	ntenance, et gement.
). Malle	1) ; 2) ; 3) ; 4) ; 5) ; 6) ; 6) ; 10) ; 11) ; 12) ; 13) ; 14) ; 15) ; 16) ; 17) ; 18) ; (19) ; (20)	Securing Recruitin Fraining Improving Improving Increasin Reducing Modernisi Procuring Using loc Introduci Intensify Developin Strengthe Expanding Obtaining Utilising	funds g good workers quality g productivi costs g delivery p defective ra ng equipment good & chea al materials ng new techn ing R & D ac g new higher g production ning marketi export overseas ma	ty eriod tio s & machiner p materials & component ologies tivities value-added ng rket informa informations incentives	& components s products tions	3		
Please	put o	nly Seria	l Number in	next column	in order of	concern.		
		`	()	(:::)	(:)	()]	

(i)	(ii)	(iii)	(iv)	(y)
(vi)	(vii)	(viii)	(ix)	(x)
(xi)	(xii)	(xiii)	(xiv)	(xv)

F. TECHNICAL TIE-UPS/JOINT VENTURES 1. Technical Tie-ups (1) Any Technical Tie-ups made at present? ☐ Have ☐ Do not have · If have, with which countries? □ U.K. □ U.S.A ☐ Japan Others (please specify): (2) Any or any more Technical Tie-ups to be desired? ☐ Have ☐ Do not have 1) If have, with which counties? □ U.K. U.S.A Japan Others (please specify): 2) What to be expected from partner companies? ☐ Technology transfer ☐ Employees training Overseas markets developed by partner companies ☐ Knowledge of management Others (please specify): 2. Joint Ventures (1) Any Joint Ventures to be desired? ☐ Have ☐ Do not have (2) If have, with which countries? □ U.K. U.S.A. ☐ Japan Others (please specify): (3) What to be expected from partner companies? ☐ Technology transfer ☐ Employees training Overseas markets developed by partner companies ☐ Knowledge of management ☐ Finance Others (please specify):

G. PROBLEM AREAS

1.	Problems	of manufacturing Shortage of production volume Lack of modern type machinery & equipment Lack of technology for reducing defects Lack of technology for making high quality products Unavailability of materials for making high value-added products Lack of technical information of products Low level productivity Others (please specify):
2.	R	of sales & exports Local market demand is small No experience in export Price level is relatively low Required technology level is too high Too much competitors existing Others (please specify):
3.	Problems	of labour management Shortage of workers Lack of skilled workers or technical staffs Frequent job hopping Rapid increase of labour costs High fringe benefit payment Increased training expenses Difficulty in labour negotiation Others (please specify):

4. Problems of using incentives

	1		Using			
Incentives	Not using	Very effective	Effective	Not effective		
• Pioneer Status			П	Д		
• Investment Tax Allowance			<u> </u>			
• Accelerated Depreciation Allowance		П	Д			
• Reinvestment Allowance						
• Export Credit Refinancing				· D		
 Abatement of Adjusted Income for Export 						
 Double Deduction of Export Credit Insurance Premiums 						
 Double Deduction for Promotion of Export 			П			
 Industrial Building Allowance for Export 			D			
• Double Deduction for R & D		Д	П	П		
• Industrial Building Allowance for R & D	0		П			
• Double Deduction for Training	<u> </u>]	<u> </u>		
 Industrial Building Allowance for Training 						

• If not using, what are the major reasons?
☐ No knowledge of measures ☐ Too complicated procedures ☐ Slow approval of measures ☐ Doubtful effects ☐ Others (please specify) :
5. Problems of Fund Raising
(1) Extent of difficulty in raising funds ☐ Very difficult ☐ Somewhat difficult ☐ Easy
(2) Major problem areas in recruiting funds in Malaysia ☐ Severe loan eligibility ☐ Financial institutions require collateral for a loan ☐ Financial institutions require guarantee of the parent company ☐ Financial institutions take much time for screening ☐ Troublesome formalities of borrowing procedures ☐ Loan amount is limited ☐ High interest rate ☐ Exposure to exchange risk ☐ Undeveloped stock market in Malaysia ☐ Lack of access to the international financial market ☐ Company's financial manager is poor in know-how of financing ☐ Others (please specify):
Thank you for your cooperation.
Please return immediately.
Name:
Signature:

II-3 List of Companies which Responded to the Questionnaire Survey in Malaysia

$\mathrm{II}-\mathrm{3}$ List of Companies which Responded to the Questionnaire Survey in Malaysia

- 1. Adamai Sdn Bhd
- 2. Alcast Sdn Bhd
- 3. Alloy Art Sdn Bhd
- 4. Automated Engineering
- 5. Bengkel Choy Soon Heng Sdn Bhd
- 6. Butterworth Foundry
- 7. Casting Industries Sdn Bhs
- 8. Cast Iron Products Sdn Bhd
- 9. Chee Peng Castion Mfr.
- 10. Chee Woh & Co Foundry
- 11. Central Foundry (M) Sdn Bhd
- 12. Cheong Hin Foundry Works
- 13. Chin Wooi Foundry
- 14. Chye Yew Sens
- 15. Choong Fei Foundry & Die
- 16. Choong Kee Foundry
- 17. Choong Lian Foundry
- 18. Chop Seng Huar Hardware
- 19. Cyclo Motor Industries Co
- 20. Dah Yung Steel (M) Sdn Bhs
- 21. Die Casting Products Sdn Bhd
- 22. Finecast Industries Sdn Bhd
- 23. Gah Hup Seng Sdn Bhd
- 24. Heng Loong Machinery & Trading
- 25. Heng Yuen Factory
- 26. Ho Yow Foundry
- 27. Hung Chang Machine Moulding
- 28. Hup Ngai Loong Foundry Sdn Bhd
- 29. Indah Foundry Sdn Bhd
- 30. Kejuruteraan Soon Way
- 31. Kin Lee Engineering Works & Trading
- 32. Kinko Steel Mill Bhd
- 33. Kit Loong Foundry

- 34. Kolling Engineering Sdn Bhd
- 35. Kong Lit Factory
- 36. Kong Foundry
- 37. Kwan Cheong Engineering (1976) Sdn Bhd
- 38. Kwong Hup Cheong Foundry
- 39. Kwong Hup Seng Engineering Sdn Bhd
- 40. Kwong Yee Loong Engrg & Foundry Workd
- 41. Lek Foong Foundry
- 42. Lien Seng Trading & Foundry
- 43. Lian Aik
- 44. Lien Yaik Hardware (M) Sdn Bhd
- 45. Lienyeu Seng Foundry
- 47. Meng Seng Hup Kee Casting & Engineering
- 48. Menglembu Wah Cheong Foundry Sdn Bhd
- 49. Metik Industry Berhad
- 50. Ngai Hing Foundry Works
- 51. Ngai Sum Engineering Foundry
- 52. Num Soon Metal Mfg Sdn Bhd
- 53. Prudence Metals Sdn Bhd
- 54. Sapura Automotive Ind Sdn Bhd
- 55. See Seng Foundry Works
- 56. Seng Fatt Engineering Works (1947) Sdn Bhd
- 57. Seng Fatt Foundry Works
- 58. Siew Cheong Foundry Works
- 59. Sin Ngai Seng Engineering Works
- 60. Sin Soon Hoe Foundry Engrg Works
- 61. Soon Fatt Engineering Works
- 62. Soon Seng Foundry
- 63. Soon Woh Foundry
- 64. Success Mahcinery & Foundry Works
- 65. Sun Chup Seng Foundry Sdn Bhd
- 66. Sun Kong Luen Cheong Foundry Sdn Bhd
- 67. Sun Sang Heng Kee Foundry Sdn Bhd
- 68. Sun Weng Heng Hup Kee Foundry
- 69. Syt Thong Sum

- 70. Taimoi Tap Industries Sdn Bhd
- 71. Tasek Iron & Steel Foundry Sdn Bhd
- 72 Teak Heng Foundry Sdn Bhd
- 73. Thong Sim Metal Casting & Engrg Works
- 74. Tick Tor Engineering Works
- 75. Tung Liang (M) Ind Sdn Bhd
- 76. United Casting Sdn Bhd
- 77. Universal Foundry Sdn Bhd
- 78. Wing Kong Foundry
- 79. Weng Seng Engineering Works
- 80. Wong Choong Foundry
- 81. Wong Weng Kong Foundry Works
- 82. Yew Hup Seng Foundry
- 83. Yew Lean Foundry
- 84. Yoon Foh Fatt Foundry
- 85. Yoon Steel (M) Sdn Bhd
- 86. Yuen Lee Casting
- 87. Zinc Alu Castin Sdn Bhd
- 88. Nan Young Foundry & Co
- 89. Lin Hup Foundry & Industry Works
- 90. Hup Heng Foundry Works
- 91. Hup Lek Foundry Factory
- 92. Speedmark Industrial (M) Sdn Bhd
- 93. Chap Huat Hardware Mfrg
- 94. Sin Ban Seng Foundry
- 95. Hunta Foundry (M) Sdn Bhd
- 96. Yin Sin Foundry
- 97. Young Cheng Foundry Sdn Bhd
- 98. Sin Tong Fatt Foundry
- 99. Hup Yik Foundry
- 100. Super Liner Industries Sdn Bhd
- 101. Dai Hing Die Casting Industry Sdn Bhd
- 102. Hoong Yuen Hing Iron Works
- 103. Ho Weng & Sons Engr Works

II-4 Results of the Questionnaire Survey in Malaysia on Tie-ups with Foreign Firms

$\Pi-4$ Results of the Questionnaire Survey in Malaysia on Tie-ups with Foreign Firms

(1) Technical Tie-Ups

1) Current tie-ups

Based on the results of the current questionnaire survey, only four of the 103 respondents were currently involved in technical tie-ups with foreign firms. Two of these were iron-related firms, and the other two were involved in die-casting. One of the cast iron foundries is a new factory which began operation in 1989, while the other three factories have been in operation since the early 1970s. All of the factories are located in Kuala Lumpur and Selangor. The partner firms are of Japanese, British, Taiwanese, and Netherlands nationality.

2) Desire for technical tie-ups

26 of the respondents indicated that they would like to participate in technical tie-ups in the future. Three of the 26 factories already had such tie-ups but began operations long ago.

Table I-1 shows the results of the survey question concerning the desired nationality of the tie-up partner.

Table [-1 Desired Nationality of Tie-up Partner

nt		No.of employees			Desired nationality						
Type No.of —— Production factories ~	~30	31~	Japan	U.S.	Taiwan	U.K.		Aust- ralia	Singa- pore	Other	
Cast iron	15	7	8	10	5	7	1	1	2 -	1	5
Steel castin	g 4	1	3	3	3	1	2	1			
Light alloys		5	2	6	2						
Total	26	13	13	19	10	8	3	2	2	1	5

Source: Questionnaire Survey

Note: The desird nationality question permitted multiple responses (the numbers indicate the number of companies not having such a desire).

13 of the factories with up to 30 employees were enthusiastic about techical tieups, as were 13 of those with 31 or more.

Japan was the most desired tie-up partner, followed by the U.S. and Taiwan. "Other" covers those responses for which no nationality was given.

Areas in which assistance from the prospective partner were anticipated included the transfer of technology, the access to new markets already developed by the partner cooperation, and employee training opportunities. Table I-2 offers a summary of anticipated areas of assistance.

Table I-2 Areas in Which Assistance is Anticipated

	N	Type of production				
	No. of factories	Cast iron	Steel casting	Light alloys		
Technology transfer	22	13	2	7		
Access to new Markets	19	10	3	6		
Employee training	15	10	3	2		
Management know-how	¥ ver	1				
Total	57	34	4	15		

Source: Questionnaire Survey (103 respondents)

Note: The totals take into account multiple responses.

(2) Capital Tie-Ups

1) Current tie-ups

Eight of the 103 respondents were currently involved in joint-capital ventures with foreign corporations. These included six factories of cast iron, one of steel casting, and one of light alloys. The partners were of Taiwanese, Singaporean and Indonesian nationality.

In addition to these eight factories, two of he factories visited were involved in capital tie-ups with firms from Japan and Singapore for the production of cast iron and light alloys.

2) Desire for capital tie-ups

18 of the 103 respondents indicated that they would be interested in participating in capital tie-ups. One of the 18 factories, a cast iron factory, was already involved in such a tie-up.

The 18 factories included 14 of cast iron foundries, three of steel casting, and one of light alloys. Table II-3 shows the desired partner nationalities indicated by the 18 factories.

Table I-3 Desired Nationality of Capital Tie-up Partners

m	М	No.of e	mployees		Desired nationality					
Type No.of Production factries	~30	31~	Japan	U.S.	Taiwan	U.K.	West Germany	Singa- pore	Other	
Cast iron	14	8	6	5	2	5	1	1	1	6
Steel casti Light alloy		1 1	2	3	2	2	2	1		1
Total	18	10	8	8	. 4	7	3	2	1	7

Source: Questionnaire Survey

Note: The desird nationality question permitted multiple responses (the numbers

indicate the number of companies not having such a desire)

There was an overall desiste for capital tie-ups regardless of the size of the company. This was true in the case of technical tie-ups as well.

Again, Japan was the most often-indicated partner, followed by Taiwan and the U.S.

At present there are no tie-ups of either sort with U.S. firms, but it is note-worthy that a number of Malaysian companies are interested in building such a relationship.

Just as in the case of technical tie-ups, areas in which assistance from the prospective partner were anticipated included the transfer of technology, the access to new markets already developed by the partner company, and opportunities for employee training. Naturally, the desire for assistance in raising funds was also indicated by many of the firms. Table I-4 offers a summary of anticipated areas of assistance.

Table II-4 Areas in Which Assistance is Anticipated

	No. of factories	Type of production				
		Cast iron	Steel casting	Light alloys		
Technology transfer	18	14	3	1		
Access to new markets	18	14	3	1		
Employee training	16	12	3	1		
Fund raising	16	12	3	1		
Management know-how	3	1				
Total	71	53	12	4		

Source: Questionnaire Survey (103 respondents)

Note: The totals take into account multiple responses.

II-5 List of Castings Currently Produced in and Exported from Malaysia

II-5 List of Castings Currently Produced in and Exported from Malaysia

(1) Production Items

A. Rubber Industry

- 1. Rubber processing machinery
- 2. Rollers
- 3. Gears
- 4. Bearing housing
- 5. Chain gears
- 6. Pulleys

B. Building Material Industry

- 1. Pipe and pipe fitting
- 2. Manhole cover
- 3. Valves
- 4. Hydrant
- 5. Pumps
- 6. Lamp posts
- 7. Coupling for pipe
- 8. Gibault joint and saddle
- 9. Weight blocks for lifts
- 10. Surface box
- 11. Concrete mixer parts
- 12. Pile shoes
- 13. Sanitary parts

C. Mining Industry

- 1. Water pumps and gravel pumps
- 2. Pump liner
- 3. Impeller
- 4. Coupling for machine
- 5. Pump casing
- 6. Dredging parts
- 7. Bushes
- 8. Sledge

D. Automobile Industry

- 1. Brake drum
- 2. Clutch disc
- 3. Exhaust manifold
- 4. Cylinder liner
- 5. Air-condition bracket
- 6. Air-condition pulleys

E. Motorcycle Industry

- 1. Kick starter lever
- 2. Piston
- 3. Brake drum
- 4. Block Manifold
- 5. Cylinder block
- 6. Cylinder head
- 7. Crank case
- 8. Disc brake set
- 9. Brake shoe

F. Railway Industry

- 1. Brake drum
- 2. Wheels

G. Palm Oil Mill Industry

- 1. Worm screw
- 2. Sleeves
- 3. Pulleys
- 4. Boiler parts
- 5. Furnace grate
- 6. Dust collector parts
- 7. Sterilizer
- 8. Digester

H. Timber Industry

- 1. Saw-mill machinery
- 2. Dust pumps
- 3. Machine parts
- 4. Rollers

I. Brick Industry

- 1. Brick making machinery
- 2. Gears
- 3. Wheels
- 4. Pulleys
- 5. Bushes
- 6. Screw housing
- 7. Shovel conveyor

J. Quarry Industry

- 1. Coupling
- 2. Crusher
- 3. Grinding

K. Agriculture Machinery Industry

- 1. Chain gear
- 2. Bucket teeth
- 3. Bucket
- 4. Dredging
- 5. Weight blocks

L. Marine Industry

- 1. Propeller
- 2. Inpeller
- 3. Shaft
- 4. Couplings
- 5. Ship trimmings

M. Chemical & Food Processing Industry

- 1. Valves
- 2. Pipe fitting
- 3. Joints
- 4. Boiler parts
- 5. Pulley
- 6. Impeller
- 7. Dust collector parts

N. Electrical Equipment Industry

- 1. Motor casing
- 2. Bearing housing
- 3. Protection box
- 4. Sleeve bushing
- 5. Grinding
- 6. Fan for motor
- 7. Induction motor

0. Telecommunication Industry

- 1. Telephone junction box
- 2. Manhole cover
- 3. Joints
- 4. Steps

P. Cement Industry

- 1. Crushers
- 2. Pulley
- 3. Stone barrel
- 4. Rollers
- 5. Sleeves for cement concrete vehicles 5.
- 6. Others

Q. Glass Industry

- 1. Glass moulds
- 2. Others

R. Plastic Industry

- i. Die set
- 2. Mould components

S. Weighting Equipment Industry

- 1. Weights
- 2. Components

T. Sport Equipment Industry

- 1. Weights
- 2. Components

U. Overhead Crane

- 1. Rollers
- 2. Others

V. Machinery Parts

- 1. Pulley
- 2. Coupling
- 3. Gear
- 4. Shaft
- 5. Tools
- 6. Wheels
- 7. General engineering parts
- 8. Others

W. Water Treatment Equipment

- 1. Self priming pump
- 2. Centrifugal pump
- 3. Valves
- 4. Others

X. Diesel Engine and Parts

- 1. Engine
- 2. Cylinder block
- 3. Cylinder head
- 4. Crane case
- 5. Others

Y. Petroleum Industry

- 1. Gas cooker
- 2. Station manhole for understand storage tank
- 3. Engineering parts
- 4. Pipe fittings
- 5. Valve
- 6. Others

(2) Export Items

Industry

Rubber Processing

Particulars Rubber Creppers

Hammer Mills Transfer Pumps Prebreakers

Valves

Manufacturers

Kwan Cheong engineering

Sphere Corporation Guthrie Engineering

Palm Oil Processing

Screw Press Bogie Wheels

Ballards Capstans

Elevator Sprockets

Oil Pumps

Boiler Fire Bars

Valves

Kumpulan Emas

Mechmar Bell Bhd Kai Peng Engineering Wong Heng Engineering

Dah Yung Steel Sin Soon Hoe

Building Industries

Cast Iron Pipes

Cast Iron Fittings

Manhole Covers

Valves Hydrant Pumps

Lift Counterweight

United Castings Sdn. Bhd.

Nam Soon Metals

Seng Fatt Engineering

Mining Industries

Water Pumps Pumps Casing Impeller Dredge Buckets

Monitor

Band saw

Fan Casing

Tin Dredge Parts

Bradken Malaysia Yoon Steel Foundry

Alloy Arts Foundry Nam Yong Foundry

Tick Tor Foundry

Yew Hup Seng Foundry Kwong Hup Seng Foundry Sin Soon Hoe Foundry Kwong Yee Long Foundry

Marine

Timber

Trolleys Propeller Shafts Coupling

Anchors

Cheong Foundry

Yoon Steel Foundry

Dah Yung Steel

Quarry

Cone

Crusher jaw Wearing parts

(Source: MIDA)

III Computers and Computer Peripherals

III-1 List of Companies and Organizations Visited

List of Companies Visited (Computer Industry Group)

	Company	<u>Address</u>	<u>Tel No.</u>
I. Compu	iter Related Industries	•	
. 1.	NEC Sales (Malaysia) Sdn Bhd	13th Floor, Bangunan Arab Malaysian, Jin Raja Chulan 50200 Kuala Lumpur	2387788
2.	Microcomputer Systems (M) Sdn Bhd	Level 3, Amoda Bilding Jalan Imbi, 55100 K L	2486655
3.	Computer Resources Sdn Bhd	Lot G46 & G49 Ground Floor Imbi Plaza, 28 Jalan Imbi 55100 Kuala Lumpur	2434462
4.	Microbase Electronics Sdn Bhd	Lot G20 & 21, Ground Floor Imbi Plaza, 55100 K L	2424549
5.	Techtrans Computer System Sdn Bhd	14 Lorong Jaya 14 c/o Taman Teknologi Malaysia Bandar Tun Razak, Ceras 56000 Kuala Lumpur	9302252
6.	Compex Systems Sdn Bhd	No. 1 Jalan Sarawak Off Jalan Pudu, 55200 K L	2418844
7.	Wearns Electronics (M) Sdn Bhd	99 Jalan Parit Masjid 82000 Pontian, Johor	871611
8.	Mitsumi Technology (M) Sdn Bhd	Batu 34 1/2 Jln Johor 82000 Pontian, Johor	878081
9.	Fujitsu Component (M) Sdn Bhd	No. 1 Lorong Satu Kawasan Perindustrian Parit Raja 86400 Batu Pahat, Johor	482111
10.	Maxtor Singapore 1td	2018 Solok Perusahaan 3 Prai Industrial Estate 13600 Penang	396500
11.	Conner Peripherals Malaysia Sdn Bhd	981 Lot 19 Mukim 1 Solok Perusahaan 3 Kawasan MIEL, 13600 Prai	390500
12.	Powermatic Sdn Bhd	Lot 5 Jalan Bersatu 13/4 46200 Petaling Jaya	7575600
13.	PK Electronics Industries Sdn Bhd	No. 53 Senawang Industrial Estate, 70450 Seremban	772993
14.	Menang Microelectronics Sdn Bhd	12 (Block B), Malaysia Technology Park Jalan Jaya 5 Bandar Tun Razak 50758 Kuala Lumpur	9312693
15.	Kobe Prcision	Lot 72, Sektor A Kawasan Perindustrian HICOM Shah Alam	5111120
16.	Accent Technology	The Annex, Plaza MBF, Jalan Ampang, 50450 Kuala Lumpur	2618444
17.	Astec (M) Sdn Bhd	A 1445 Jalan Tanjung Api 25050 Kuantan, Pahang	515522

II. Assemblers of Electronics Products

1.	JVC Electronics Malaysia Sdn Bhd	Lot 1, Pesiaran Jubli Perak Seksyen 22, 4000 Shah Alam	5413377
2.	NEC Home Electronics	Lot 9, Kaw Perusahaan Tikam Batu, 08007 Sungai Petani	478700
3.	SONY Electronics (M) Sdn Bhd	Free Trade zone Prai Industrial Estate 13600 Prai, Penang	396400
4.	Sharp-Roxy Corporation (M) Sdn Bhd	Lot 202, Bakar Arang Ind Estate, 08000 Sg. Petani Kedan	412854
5.	Sharp Roxy Electronics Corp (M) Sdn Bhd	Plo No. 1 Kawasan Perind Sri Gadang 83009 Batu Pahat, Johor	445466
6.	Brother Industries Technology (M) Sdn Bhd	Lot 62, Tebrau Ind Estate 81200 Johor Bahru, Johor	542107
Ⅲ. Manu	facturers of Electronics Parts		
1.	Rohm-Wako (Malaysia) Sdn Bhd	Lot 58, Jalan 26/6 HICOM Industrial Estate 40000 Shah Alam	5111313
2.	MC Industry	Plot 1240, Bayan Lepas FTZ 11900 Penang	833511
3.	Toshiba Electronics (M) Sdn Bhd	42507 Telok Panglima Garang 15 Km Klang-Banting Road Kuala Langat, Selangor	3526001
4.	Toshiba Capacitor (M) Sdn Bhd	Telok Panglima Garang (FTZ) 15KM, Jalan Kelang Banting Kuala Langat, Selangor	3526001
5.	Matsushita Electronic Components (M) Sdn Bhd	No. 1 Jalan SS 8/4 Sungei Way FTZ, Selangor	7760899
6.	Kami Electronics Industry (M) Sdn Bhd	5A Jalan Hasil Off Jalan Tampoi 81200 Johor Bahru	378405
7.	GG Circuits Industries Sdn Bhd	No. 10D & E, 5 ² / ₁ Miles Jalan Skudai, Tampoi 81200 Johor Bahru	368935
8.	Alps Electroncis (Malaysia) Sdn Bhd	Lot 15. 02A, 15th Floor Menara Promet Jalan Sultan Ismail 50250 Kuala Lumpur	2436682
9.	Hitachi Consumer Products	Lot 4 Jalan Pl/A K P Bangi	8250801
10.	SMK (M)	Equatorial Hotel	-

IV. Manufacturers of Metal Products

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VI.

1.	Kris Componets Sdn Bhd	11A Lorong 2A, Ceras Jaya Jalan Belakong, 43200 Ceras Selangor	9055117
2.	Kein Hins Industry Sdn Bhd	1837 Jalan College 43300 Seri Kembangan Selangor	9486820
3.	Loon Sunn Engineering Sdn Bhd	8233 Jalan 225 46100 Petaling Jaya	7561655
4.	Hip Hoe Engineering Works Sdn Bhd	33 Jalan Kampong Pasir Baru Batu 6, Jalan klang Lama 58200 Kuala Lumpur	7921549
5.	Loh Kim Teow Engr Sdn Bhd	31-34 Lengkok Kampong Java 2 Bayan Lepas Non-FTZ 11900 Penang	837999
6.	Eng Hardware Engr Sdn Bhd	Plot 69, Persiaran Kampong Jawa, Bayan Lepas Non-FTZ 11900 Bayan Lepas, Penang	840122
7.	Ban Seng Lee Industries	Lot 1030, Jalan Besar Selayang Baru 68100 Batu Caves	6187148
Manuf	acturers of Plastic Injection M	oulding Parts	
1.	Polynic Industries Sdn Bhd	Lot 256, Mak Mandin Industrial Estate 13400 Butterworth	345569
2.	Precico Sdn Bhd	Plo 410, Lrg Perusahaan 8B Prai Industrial Estate 13600 Prai, P W	307414
3.	May Plastics Industries	No. 15 Jalan 113 Kaw Perindustrian Kepong Baru 52100 Kuala Lumpur	6344180
4.	Yong Kam Fook Plastic Ind Sdn Bhd	20/69 Persiaran Selangor 40700 Shah Alam	5590152
5.	Itami Plastic Corp (M) Sdn Bhd	Plo 2, Kawasan Perindustrian 83300 Sri Gading, Batu Pahat Johor	4882667
6.	Kohno Plastic (M) Sdn Bhd	Lot 79 Lorong Enggang 35 Kawasan Perusahaan Bebas Ampang Ulu Kelang 54200 Kuala Lumpur	4566622
Relat	ed Organisations and Others		
1.	Malaysian National Computer Confederation (MNCC)	46A Jalan SS 2/66 47300 Petaling Jaya	7751576
2.	Federation Manufacturers Malaysia (FMM)	17th Floor, Wisma Sime Darby Jalan Raja Laut, 50350 K L	2931244

3.	INTAN Computer Training Centre	Jalan Elmu, 59700 K L	7578253
4.	Persatuan Industri Komputer Malaysia (PIKOM)	25th Floor, Menara Tun Razak Jalan Raja Laut, 50350 K L	2920297
5.	Syarikat Telekom Malaysia	STM Headquarters, 20th Floor Bukota Building Jalan Pantai Baru, 59200 K L	2329494
6.	Malaysian Institute of Microelectronic Systems (MIMOS)	Lot 7.2 & 7.3 7th Floor, Kompleks Bukit Naga Off Jalan Semantan Damansara Heights, 50490 K L	2552700
7.	Penang Development Corp	No. 1 Jalan Sungei Nibong 11909 Bayan Lepas, Penang	832111
8.	Akitek MAA	Bangunan Ming 15-01 15-01, Jalan Bukit Nahas 50714 Kuala Lumpur	2308955
9.	Sumitomo Corporation	15th Floor, UBN Tower 10 Jalan P Ramlee 50710 Kuala Lumpur	2308133
10.	Malaysian Plastic Manufacturers' Association (MPMA)	37, 2nd Floor, Jalan 20/14 Paramount Garden 46300 Petaling Jaya	7763027
11.	Malaysian Technology Park	Lot 8-12 Block A Jalan Jaya 5 Taman Jaya Bandar Tun Razak Tun Abdul Razak 56000 Kuala Lumpur	9307088
12.	MAMPU	4th Floor, Wisma PKNS Jalan Raja Laut 50527 Kuala Lumpur	2982066
13.	Japan Asean Investment Corporation (JAIC)	16th Floor, UBN Tower 10 Jalan P Ramlee 50710 Kuala Lumpur	2304031
14.	The Nomura Securities Co., Ltd.	24th Floor, UBN Tower No.10 Jalan P. Ramlee 50250 Kuala Lumpur	2305659
15.	Pahang State Development Corporation	16th Floor Kompleks Teruntum, Jalan Mahkota 25000 Kuantan Pahang	505566

III-2 Questionnaire Sheet for Survey in Malaysia

THE STUDY ON SELECTED INDUSTRIAL PRODUCT DEVELOPMENT IN MALAYSIA FOR ELECTRICAL AND ELECTRONICS RELATED INDUSTRIES QUESTIONNAIRE SHEET

1	COMPANY	OUTL	INE
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(1)	Name of Company	
(2)	Address of Head Office	
	TEL	
	FAX	
(3)	Name of Chief Executive	
(4)	Year of Establishment	
(5)	Number of Employees	
(6)	Paid-up Capital	
(7)	Anual Sales Value('88)	
	Turnover ('88)	
	Export Sales Value	
	Export Ratio	
(8)	Capital Structure	
	Local	<u> </u>
	Foreign .	
	To Foreign Affiliate	d Firm
	Name of Parent F	irm
	Nationality of Pa	arent Firm
(9)	Products	
	(a) Major Products	
	(b) Minor Products	
(10)	Respondents	
	Name:	
	Title:	
		A-48

2 GENERAL QUESTIONS 2. 1 At present, what are the main problems in your company management? ☐ Procurement of funds ☐ Introduction of new technology ☐ Purchasing of materials ☐ High rental fees of land and buildings □ Difficulties in finding personnel ☐ Severe competition ☐ Low operating rate □ Others (Specify 2. 2 Regarding industrial associations, (1) At present, are you a member of some sort of industrial association? ☐ Yes (Its name is _____ (2)What do you believe are the current advantages of entry into an industrial association? ☐ Acquisition of marketing information ☐ Greater opportunity for the finding of business partners ☐ Stronger negotiating power with the Government Others (Specifly______) □ Nothing in particular □ No idea (3)Is there anything you feel an industrial association should pursue in the future? ☐ Joint purchase of materials ☐ Sponsoring of product exhibitions, business conferences, etc. ☐ Periodic supply of information. Others (Specifically______) □ Nothing in particular □ No idea Do you think it necessary to establish an industrial association specialized in electronics industry?

A-49

□ Yes

□ No

2.	3 Regarding quality control,
(1)	Are you implementing QC activities? Yes No Have no knowledge about QC
(2)	If provided in the future, which of the following would you want to make use of? Seminar concerning QC methods On-the-spot guidance by specialists visiting each factory Supply of QC manuals Training by dispatching the management staff to Japan Subsidy for the use of QC consultants Others (Specify)
2.	4 Regarding technical tie-up
(1)	Have you had experience with a technical tie-up or Original Equipment Manufacture(OEM) arrangment? Have had technical tie-up Have had OEM deal No
(2)	How did you find your partner in the technical tie-up or OEM arrangement? Offer from partner Uncovered by oneself Introduced by third party Others (
(3)	Do you know of the MIDA system for introduction of partners for technical tie-ups (RICOM)?
	☐ Yes ☐ No ☐ Have used same and found it effective ☐ Have used same, but did not lead to contract
(4)	Do you have any intention to start the production of personal computer, peripherals and related parts in futher? Have a concrete plan (Product:) Have interest (Product:)
(5)	Do you desire a technical tie-up or OEM arrangement or Joint Venture with a foreign firm concerning production of personal computer and peripherals? Would like a technical tie-up Would like an OEM arrangement Would like a Joint Venture with a foreign firm No

3 QUESTIONS AS TO PERSONNEL DEVELOPMENT

3. 1 Present Employment in Production Department

(1)
Please enter the numbers of factory workers in the following table by type of workers and by academic back ground.

Type of Workers	System Engineer	Prog- rammer	Engineer	Techni- cian	Super- visor, Fore-	Skilled Worker	Non- skilled Worker
Academic Background					man		
Primary School		,					
Lower Secondary School							
Upper Secondary School							
Polytechnic							
University							
Vocational Training Institutions							

3.	2	Shortage	of	Labour

(1)	ls	the	shortage of manpower becoming a problem in your company?
			It is a serious problem.
			It is somewhat a problem.
			It is not a problem.

When your company faces a manpower problem:
Which types of workers are insufficient?

	A serious problem	Somewhat a pr <u>oblem</u>	Not a problem
Engineer			
Technician			
Supervisor, Foreman			
Production line worker			
R&D personnel			
System engineer			
Programmer			
Manager			
Salesperson			
Clerical worker			

t.h∉	ich types of work coming 5 years? ease indicate the	•					our compan	y in
			Very i	nsufficien	Somewl	nat <u>Ticient</u>	Sufficie	<u>nt</u>
	□ Engineer							
	□ Technician							
•	□ Supervisor,	Foreman				1		
	☐ Production	line worke	r			l		
	☐ R&D personr	nel						
	□ System engi	neer	•		(_]		
	□ Programmer					l		
	☐ Manager							
	☐ Salespersor	n ·						
	□ Clerical wo	orker				!		
	ase enter the num						co employ	in
1	Type of Workers	System	Prog-	Engineer	Techni-	Super-	Skilled	Non-
	Type of Workers	System Engineer	Prog- rammer	Engineer	Techni- cian	Super- visor, Fore- man	Skilled Worker	Non- skilled Worker
Acade			1	Engineer		visor, Fore-		skilled
Acade	emic Background		1	Engineer		visor, Fore-		skilled
Acade Prima Lower	emic Background ary School Secondary		1	Engineer		visor, Fore-		skilled
Acade Prima Lower	emic Background ary School Secondary School Secondary		1	Engineer		visor, Fore-		skilled
Acade Prima Lower Upper	emic Background ary School Secondary School Secondary School		1	Engineer		visor, Fore-		skilled
Acade Prima Lower Upper Polyt Unive	emic Background ary School Secondary School Secondary School		1	Engineer		visor, Fore-		skilled
Acade Prima Lower Upper Polyt Unive Vocat Insti	emic Background ary School Secondary School Secondary School technic ersity Lional Training	Engineer	term eml		cian	visor, Fore-		skilled
Acade Prima Lower Upper Polyt Unive Vocat Insti	emic Background ary School Secondary School technic ersity tional Training itutions	Engineer ve a long-	term eml		cian	visor, Fore-		skilled
Acade Prima Lower Upper Polyt Unive Vocat Insti	emic Background ary School Secondary School technic ersity tional Training itutions Has a plan f	Engineer or a long- or within	term eml 1 year.		cian	visor, Fore-		skilled

3. 4 Level of New Graduates

(1)
How do you evaluate the educational level of new graduates in Malaysia?
Please evaluate the educational level with the following score and tick in a respective column,

Score: A -Sufficiently satisfies the company's requirements.

B -Almost meets the company's requirements.

C -Is somewhat below the company's requirements.

D -ls far below the company's requirements.

Type of Institution	Α	В	С	D
School Education Facilities Primary School				
Lower Secondary School				
Upper Secondary School				
Polytechnic				
University				
Vocational Training Institutions				

3. 5 Wishes for the Expansion of Education and Training Institutions

Upon which subjects do you consider the government should place greater emphasis for middle and higher education.

Please tick in a column for subjects to be emphasized by type of institution.

Type of Institution Subject	Upper Secondary Schools	Polytechnic	Universities
Department of Engineering		·	
Electricity			
Electronics			
Information Science /Computer Science			
Communication Engineering			
Mechanical			
Chemistry			
Metal/Metalwork			
Management Engineering			
Others			
Department of Science and Mathematics			
Others ()			

3.	6 In-house Train	ning					
(1)	Does your company	have an in-h	ouse traini	ng system?			
	☐ Yes						
	□ No						
Ιf	your company chose	"Yes" in the	above ques	tion, please an	swer the ques	tions <u>(2)-</u>	<u>(5)</u> .
(2)							
•,	Which is the main	way of train	ing each ty				
		On the Job Training	Seminar Within Company	Outside Training <u>Institutions</u>	Training at the parent Company	Others	
	General Worker)
	Supervisor, Forema	ın 🗆)
	Technician						·)
	Engineer)
	Programmer					□ ()
	System Engineer)
(3)	Do you think that	NOUR GOMBANY	current ly	gives enough tr	nmant anine	lovees?	
	Do you chink that		Carreners	gives enough ti	CITITIO CO OMP	10,000.	
	□ Not E						
	If you answered "!	_	n, the ahove	musetion'			
	In which respect	is the presen	t training	system incomple	te?		
	□ Traini	ing Period					
	☐ Conter	nt and Level	of Training				
	□ Size o	of Employees	to Be Train	ed			
	☐ Facili	ities and Mate	erials				
•	☐ Others	; ()	
(4)	What are the major	oroblems in	carrying o	ut in-house tra	ining in your	company?	
		•		ve enough time			
	_	nuals are not		, , , , , , , , , , , , , , , , , , , ,	•		
				tem and plannin	g		
		are not train					
	☐ Lack of buda						
		not motivate	ed to recei	ve training.			
		of trainees va					
	☐ It is diffic	ult to invite	e outside l	ecturers and in	structors.		
	□ Outside trai	ning institut	tions do no	t prepare appro	priate curric	ula.	
	•	-		ve a limited nu			
		ning institut		insufficient eq			
	[] There is no	training inst	titution ne	ar the company.			
	□ Others ()		

(5)		ompany have a plan	to expar	nd in-house train	ning?		:
		Yes					
		No			•		
	If your comexpand?	pany have any plan,	what k	ind of training d	ioes your compa	ny plan to	
	expand:)		
Ιf	you chose "N	o" in the question	(1), ple	ease answer the q	questions <u>(6) a</u>	<u>nd (7)</u> .	
(8)		reason that your c	ompany (loes not give in-	house training	?	
		Not necessary (1	f not ne	ecessary, why?)	
		Lack of budget				·	
		Lack of know-how a	nd instr	ructors			
		Others ()		
(7)	Does your c	ompany have a plan	to start	in-house traini	ng?		
		Yes		•			
		No					
	If you answer	ered "Yes" in the q rt?	uestion	above, what kind	of training do	oes your compa	any
	-						
3.	7 Use of 0	Outside Training In	stitutio	ons			
(1)							
	Which outsid	le training institu	tes does	your company us	e for employees	s training?	
Nam	e of Trainin	<u>Institute</u>	Using	Once used, but not now.	Never used.	Do not know	
	MARA Vocation						
	CIAST						
	Industrial '	fraining Institutes					
	National Pr	oductivity Centre					
	MIDEC						
	Others ()					

(2)	How do you evaluate outside t	raining i	nstitutes?		
Nam	e of Training Institute	Useful	Somewhat Useful	<u>Useless</u>	Do not know well
	MARA Vocational Training Institutes				
	CIAST				
	Industrial Training Institute	s 🗆			
	National Productivity Centre				
	MIDEC				
	Others (
(3)			1	h	-taith alasa
	Which vocational training inst greater emphasis for vocationa Please evaluate the importance	itutions I trainin of expan	do you consider to g? ding institutions	ne government :	Do not know
<u>Name</u>	e of Training Institute	Very Imp	ortant Somewhat Importan	Not t Important	the institute
	MARA Vocational Training Institutes				
	CLAST				
	Industrial Training Institute	s 🗆			
	Youth Training Centres				
	Ministry of Welfare Services' Training Centres				
	National Productivity Centre				
	MIDEC				
	Others (D .		
(4)	In which fields of technologie	a do vou	consider the gover	enmant chauld a	wnand training
	In which fields of technologie institutions?	s do jou	Generel Worker	Supervisor, Foreman	Technician
	☐ Machine Operation				
	☐ Die Making		П		
	☐ Forging				
	□ Welding				
	☐ Metal Fabrication				
	☐ Press Work				
	☐ Foundry and Casting	•			
	☐ Rubber Moulding				
	☐ Plastic Moulding				
	☐ Electrical Engineering			[]	
	☐ Electronics Engineering				
	☐ Instructor and Supervisor	Training			
	☐ Plant Engineering				
	□ Quality Control				
	☐ Computer Science				

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with the coop	your opinion on the idea of establishing a training institution jointly eration of the public sector and private sector. This idea is that a itution be established by drawing specialized knowledge from private firms and by funding from the government.
(1) Do you thin plentiful s	k that this type of institution is necessary for the realization of upply of skilled labour?
	Necessary
	Not Necessary
(2) Will you on	nd employees to that institution if it is put into operation?
iiii you se	Yes
П	No
(3)	
Upon which	types of training do you consider that institution should place emphasis?
	Training of Generel Workers
	Training of Foremen or Supervisors
	Training of Technicians
	Training of Engineers
(4) Will you pro	ovide cooperation to that institution?
. 0	Yes
	No
If answered	"Yes", which types of participation may be possible?
	Dispatch of instructors
	Provision of machinery and equipment
	Offering of building
	Provision of funds
3. 9 Govern	ment Support
(1) Boss your	company receive training incentive?
	Yes
(2)	10
What are	the problems of the Government's training incentive scheme?
	Small benefit from incentive
	Complicated formalities
	Narrow eligibility for incentive
	Little knowledge of training incentive
	Others () A-57

4 QUESTIONS AS TO FINANCING

4. 1 Fund Raising
(1) How much has your company raised funds in the past 2 years?
Amount Thousand M\$
(2)
What are the uses of the fund recruited in the past 2 years?
☐ Increase in working capital due to the growth of sales
□ Construction of a new plant
☐ Replacement or modernization of production facilities and equipment
☐ Setting-up of branch offices
☐ New product development
☐ Business diversification
□ Making-up for loss
□ Others (
(3) From what sources has your company raised funds in the past 2 years?
□ Borrowing
(From Lenders in Malaysia)
☐ Public Financial Institutions
☐ Private Financial Institutions
Private Companies and Persons
☐ Parent Company and Related Companies
(From Lenders Overseas)
☐ Financial Institutions
☐ Parent Company and Related Companies
□ Others
□ Lease
☐ Issuance of Stock
(4) How much is your company going to recruit funds in the coming 2 years?
Total amount Thousand M\$

(5) What a	re the major uses of funds to be recruited in the coming 2 years?
	Increase in working capital due to the growth of sales
	Construction of a new plant
	Replacement or modernization of production facilities and equipment
	Setting-up of branch offices
	New product development
	Business diversification
	Making-up for loss
	Others (
(6) From t	what sources would your company expect to recruit funds in the near future?
	Borrowing (From Lenders in Malaysia) Public Financial Institutions Private Financial Institutions Private Companies and Persons Parent Company and Related Companies (From Lenders Overseas) Financial Institutions Parent Company and Related Companies Others Lease Issuance of Stock
4, 2□	Problems of Fund Raising
(1)	
Does	your company have difficulty raising funds ?
I	□ Very difficult
!	□ Somewhat difficult
I	□ Easy
(2) What	kind of difficulty does your company have?
(Severe loan eligibility
i	Thinancial institutions require collateral for a loan,
I	
1	☐ Financial institutions take much time for screening.
1	Troublesome formalities of borrowing procedures
1	□ Loan amount is limited.
1	□ High interest rate
l	Exposure to exchange risk
į	□ Undeveloped stock market in Malaysia
	☐ Lack of access to the international financial market
1	Company's financial manager is poor in know-how of financing.
i	Others ()

Does your company borrow toans through the CGC schemes? Using	4. 3 Use of the creat aurantee system
Once used, but not using now. Never used. If your company has never used a loan with CCC's guarantee, please answer the following questions? Have your company ever examined the use of CGC? Yes	Does your company borrow loans through the CGC schemes?
Never used. If your company has never used a loan with CGC's guarantee, please answer the following questions? Have your company ever examined the use of CGC? Yes	□ Using
Never used. If your company has never used a loan with CGC's guarantee, please answer the following questions? Have your company ever examined the use of CGC? Yes	Once used, but not using now.
If your company has never used a loan with CGC's guarantee, please answer the following questions? Have your company ever examined the use of CGC? Yes No No	
Have your company ever examined the use of CGC? Yes	
Yes	
No What are the reason of not using the CGC? Does your company have any plan to use the CGC? Yes No No	Have your company ever examined the use of CGC?
What are the reason of not using the CGC? Does your company have any plan to use the CGC? Yes	☐ Yes
Does your company have any plan to use the CGC? Yes	□ No
Yes	What are the reason of not using the CGC?
No	Does your company have any plan to use the CGC?
Do you wish the expansion of the Credit Gurantee System in Malaysia? Yes	□ Yes
Yes	□ No
No	(2) Do you wish the expansion of the Credit Gurantee System in Malaysia?
What problems does the present CGC schemes have? Complicated formalities Loan amount is small. Severe lending conditions Additional collateral is required. Eligible firms are limited only to small-scale firms We do not have enough knowledge of the system and its procedures. Others (☐ Yes
What problems does the present Cut schemes have? Complicated formalities Loan amount is small. Severe lending conditions Additional collateral is required. Eligible firms are limited only to small-scale firms We do not have enough knowledge of the system and its procedures. Others (□ No
Loan amount is small. Severe lending conditions Additional collateral is required. Eligible firms are limited only to small-scale firms We do not have enough knowledge of the system and its procedures. Others () Others () Is it necessary that the government expand financial facilities for small-scale firms in order to improve their access to financial resources outside? Very important Somewhat important Not important Not important Is there any necessity for the government to set up a special financing scheme for long-term investments by the electronics industry? Very necessary Somewhat necessary Somewhat necessary Not necessary If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate	(3) What problems does the present CGC schemes have?
Severe lending conditions Additional collateral is required. Eligible firms are limited only to small-scale firms We do not have enough knowledge of the system and its procedures. Others () (4) Is it necessary that the government expand financial facilities for small-scale firms in order to improve their access to financial resources outside? Very important Somewhat important Not important Not important Not important Very investment Somewhat investment Somewhat investment Somewhat investment Somewhat investment Somewhat investment Somewhat necessary Not necessary Not necessary Not necessary If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate Wears Wear	☐ Complicated formalities
Additional collateral is required. Eligible firms are limited only to small-scale firms We do not have enough knowledge of the system and its procedures. Others (☐ Loan amount is small.
Additional collateral is required. Eligible firms are limited only to small-scale firms We do not have enough knowledge of the system and its procedures. Others (☐ Severe lending conditions
We do not have enough knowledge of the system and its procedures. Others (☐ Additional collateral is required.
We do not have enough knowledge of the system and its procedures. Others (
Others (
Is it necessary that the government expand financial facilities for small-scale firms in order to improve their access to financial resources outside? Very Important Somewhat Important Not Important 4. 4 Financial Support System for Long-term Investment	
☐ Very Important ☐ Somewhat Important ☐ Not Important 4. 4 Financial Support System for Long-term Investment [Is there any necessity for the government to set up a special financing scheme for long-term investments by the electronics industry? ☐ Very necessary ☐ Somewhat necessary ☐ Not necessary ☐ Not necessary ☐ If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? ☐ Interest Rate ☐ Kepayment Period Years	
Somewhat Important Not Important 4. 4 Financial Support System for Long-term Investment (1) Is there any necessity for the government to set up a special financing scheme for long-term investments by the electronics industry? Very necessary Somewhat necessary Not necessary Not necessary If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate Repayment Period Years	is it necessary that the government expand illumination facilities for swall scare firms in order to improve their access to financial resources outside?
Not important 4. 4 Financial Support System for Long-term Investment (1) Is there any necessity for the government to set up a special financing scheme for long-term investments by the electronics industry? Yery necessary Somewhat necessary Not necessary Not necessary (2) If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate Repayment Period Years	☐ Very Important
4. 4 Financial Support System for Long-term Investment (1) Is there any necessity for the government to set up a special financing scheme for long-term investments by the electronics industry? Very necessary Somewhat necessary Not necessary Not necessary	□ Somewhat Important
Is there any necessity for the government to set up a special financing scheme for long-term investments by the electronics industry? Yery necessary Somewhat necessary Not necessary If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate	□ Not Important
Is there any necessity for the government to set up a special financing scheme for long-term investments by the electronics industry? Yery necessary Somewhat necessary Not necessary If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate	4. 4 Financial Support System for Long-term Investment
☐ Very necessary ☐ Somewhat necessary ☐ Not necessary (2) If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate	(1) Is there any necessity for the government to set up a special financing scheme for
Somewhat necessary Not necessary (2) If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate Repayment Period Years	long-term investments by the electronics industry?
Not necessary (2) If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate Repayment Period Years	☐ Very necessary
(2) If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate Repayment Period Years	□ Somewhat necessary
If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set? Interest Rate Repayment Period Years	□ Not necessary
Interest Rate	(2) If the government sets up a new financing scheme for long-term investment, at which level should lending conditions be set?
Repayment Period <u>Years</u>	
maximum boan amount indusand a	Maximum Loan Amount Thousand \$

5 PROMOTION OF PARTS INDUSTRIES

	For Purel	nasers of parts (Question 5.1~ 5.3)
L	TOI THIO	(question o.1 o.o)
5.		are requested to answer following question about current domestic curement of parts.
	Please giv in future	ve the approximate rates of local procurement of parts at present and
		At present (as of 1989)%
		After 5 years (expection) %
(2) I	dave the	above local procurement rates changed recently?
		Have grown considerably
		Have grown slightly
		Have not changed much
		Have fallen due to quality problems
(3)	From how	many domestic comparies do you presently procure parts?
		Its number is
(4)	₩hat is :	your intention toward raising the rate of domestic procurement?
		Very positive
		Desire to increase purchase if conditions are met
		Satisfied with current state
		Not particularly interested at present
(5)		the following items most closely expresses your policy regarding future procurement?
		Wish to raise local content through coversion to in-house manufacture
		Wish to find good local subcontractors
		Be in the process of the invitation of investment by related oversea parts manufacturers
		Cannot expect much domestically, so most rely on imports from abroad
		Nothing in particular

(6)	What are	the main methods you use for finding local parts suppliers?
		Sales efforts by suppliers
		Word of mouth communications among persons in the same industry
		Business contacts at head office
		Directories and other publications
		Introductions from the third parties/persons
(7)	How would	I you feel about the official support systems for the introduction of local ppliers?
		Necessary
		Would like to use it if estabilished
		Do not feel it would be so effective
		Not necessary
(8)	₩hat woul	d be the most desirable forms of such a service?
		Publication of periodic directories
		Provision of the latest information by on-line system
		Setting-up of periodic exhibitions
		Permanent establishment of information consultation offices
		Others (Specifically)
(9)	Do you kn	ow that the MTI is offering an introduction service of subcontractors?
		Yes
		No .
(10)	Which of	the following items would you consider most effective in raising the rate ic procurement of parts in Malaysia?
		Offering incentives for use of domestic parts
		Guidance in quality control for local parts manufacturers
		Promotion of investment in Malaysia by foreign affiliated parts manufacturers
		Arrangement of information regarding domestic parts manufacturers
		Import restrictions on parts by countries of origin
		Others (Specify)

5. 2 Please give your evaluation of domestic procuremnt of the following parts:

Score: A - Procuremnt is fully feasible at present

- $B-% \frac{1}{2}\left(\frac{1}{2}\right) =0$ Domestic parts exist, but there are some problems in quality or in securing stable supplies
- C Domestic parts currently do not exist, so domestic production is strongly desired
- $D-\ \ Domestic$ parts currently do not exist, and there are little merits in domestic procurement

Name of part	A	В	С	D
Plastic Injection Moulded Parts				
Pressed Metal Parts				
Turning Parts (Axes, Dowels)				
Die Cast Parts				. :
Rubber Rollers				
Rubber Belts				
Rubber Moulded Parts				
Screws, Washers				
Precision Springs (Coils, Sheets)				
Precision Bearings (Balls, Sintered Alloy)				
IC, LSI(MP,ROM,RAM,Gate-Alleys,TTL,etc)				
Hybrid IC				
Printed Circuit Boards(Plated Through-Holes, Multilayers)				
Resistors, Capacitors				
Variable Resistors				
Diodes,Transistors,LED				
Switches		<u> </u>		
Switching Power Supplies				
Solenoids, Coils				
Wire Harnesses, Connectors				
Photocouplers				
Electromagnetic Clutches				
DC Motors, Stepping Motors				
Fans				
Piezoelectric Buzzers				
Transformers				
Liqid Crystal Panels				
HDD / FDD				
CRT				

5.	3 I	legar	ding promotion of local companies,
(1)	Do yo	ou pr	ovide some sort of assistance to local parts manufacturers?
			Yes
			No .
(2)		اسدا	· · · · · · · · · · · · · · · · · · ·
(4)		are	the methods you use?
			Technical asssistance for the improvement of products' quality or the guidance in QC
			Assistance in training
			Financial assistance
			Provision of materials
			Provision machinery or other production facilities
			Introduction of new customers
			Others (Specify)
(3)	Which		the following do you consider to be the greatest problems faced by local sufacturers
			Lack of long-term outlook on management
			Lack of interest in improving quality
			Lack of product development and improvement capabilities
			Lack of knowledge on business practices etc.
			Lack of marketing capabilities
			Lack of engineers
(4)	Which		the following methods do you consider effective for improving the productent and improvement capabilities of local parts manufacturers?
			Provision of subsidies for R & D support organizations
			Transmission of technology through the establishment of official R & D
			support organizations
			Provision of technical information
٠			Experience through transactions with foreign affiliated companies
			Technical tie-ups with foreign affiliated companies
			Others (Specify)

	For manu	facturers of parts (Question $5.4 \sim 5.5$)				
5.		arding the marketing of the current products to domestic assemblers cluding companies in FTZ, or LMW),				
(1)	The present sales ratio of products to domestic assembly companies is					
(2)	2) How has the sales ratio for domestic assemblers changed in recent 3 years?					
		Has not changed				
		Has grown slightly				
		Has grown remarkably				
		Has fallen				
		Others (Specify)				
(3)	How many	domestic assemblers do you presently do business with?				
	Its	number is				
(4)	What are	the production items of your client assemblers?				
		Colour TV set				
		Audio Equipment				
		Air conditioner				
		Other Consumer Product				
		Semiconductor				
		Other electronic parts				
		Industrial Product				
		Others (Specify)				
(5)	What is a	your intention for the marketing expansion to domestic assemblers from				
		Under seeking for new marketing sources				
		Have intention, but of nothing concretely				
		Not particularly interested				

5.	5	Rega	rding the development of new marketing sources
(1)	What	do y	ou consider to be the major obstacles for the development of new markets?
			Lack of marketing information
			Lack of business talks and other opportunities for business expansion
		П	Lack of information on business practices, etc.
			Severe requirement on the level of technology and product quality
			Others (Specify)
(2)	W1 4		the main methods you use for developing customers?_
	mnat		
			Word-of-mouth communication
			Offers from customers
		П	Own sales efforts
			Introductions by the third parties/persons
			Participation in exhibitions, business conferences, etc.
			Insertions in directories, etc.
			Others (Specify)
(3)	Do yo	ou kn	OW of the MEXPO'S system of the introduction of overseas business partners?
			Yes
			No .
			Have used it and found it effective
			Have used it, but it did not lead to establishment of business relations
(4)	Uava	W011	ever participated in an exhibition, a business meeting, etc.?
	паче	·	
			Yes, domestically
			Yes, overseas as well
(E)			No experience
(5)	Do vo	u wi	sh to participate in an exhibition, a business meeting, etc.?
			Yes, domestically
			Yes, overseas as well
			Not interested
(6)	If yo	u an	swered "Not interested" in response to question[5], why?
			Have hands full with current orders at present
			Difficult to cover expenses
			Not expected much in terms of results
			Others (Specify)
(7)			·
(,,	Which	mar	ket do you consider most promising in the future?
			Domestic, multinational companies
			Domestic, indigenous companies
			Singapore and other nearby export markets
			Japan
			Western countries and U.S.

6 ASSISTING PROGRAMMES

Assisting programmes, which are with regard to the promotion of the electronics industry in Malaysia, have been set up as follows. Which five among those items do you consider most important?

<reg< th=""><th>arding education and training></th></reg<>	arding education and training>
	Installing more vocationnal training institutes
	Revision of curricula of vocational training institutes
	Installment of a layer number of branch schools of polytechnics
	Revision of curricula of polytechnics
	Expansion of curricula related to electronics at universities
	Construction of closer joint R&D relationships between private sectors and universisties
	Establishment of new vocational training institutions through the co-operation of both public and private sectors
<reg< td=""><td>arding fund raising></td></reg<>	arding fund raising>
	Simplification of loan procedures of financial institutions
	Amplification of long-term investment funds and financing schemes for new investments
	Amplification of low-interest loan schemes for small-and-medium scale companies
П	Amplification of CGC Schemes
<reg< td=""><td>arding management and marketing></td></reg<>	arding management and marketing>
	Preparation of domestic parts manufacturers' directories
	Improvement of the MEXPO's system of introduction of business partners, and strengthening of other assisting activities for overseas marketing
	Openings of and participating assistances for the exhibitions and business conferences of electronics products
	Establishment of subsidy systems for small-and-medium scale companies to make use of consultants
	Opening of seminars concerning management for small-and-medium sized companies
<reg< td=""><td>arding Quality Control(QC)></td></reg<>	arding Quality Control(QC)>
	Assistance for QC activities of local parts manufacturers
	Establishment of the product inspection system for improving the quality of domestic parts

<reg< th=""><th>arding technology and R&D></th></reg<>	arding technology and R&D>
	Expansion of MIDA's services for the introduction of technical tie-up of OEM partners
	Establishment of subsidy systems for strengthening R&D activities, or amplification of tax incentives
	Establishment of some public institutions supporting R&D activities in the field of electronics
<0th	ers>
	Preparation of hi-tech industrial parks (industrial estates) for the electronics industry
	Strengthening of incentives for assistances of local subcontracting companies by assemblying companies
	Amplification of the Subcontracting Scheme extended by MIT
<spe< td=""><td>cification besides those aforementioned></td></spe<>	cification besides those aforementioned>
П	

III-3 List of Companies which Responded to the Questionnaire Survey in Malaysia

List of Companies which Responded to the Questionnaire Survey in Malaysia

- 1. Action Industries (M) Sdn. Bhd.
- 2. Advanced Micro Devices Export Sdn. Bhd.
- 3. Applied Magnetics (M) Sdn. Bhd.
- 4. Asian NDK Crystal Sdn. Bhd.
- 5. Canal Electronic (M) Sdn. Bhd.
- 6. Cinetech Manufacturing Sdn. Bhd.
- 7. Clarion (M) Sdn. Bhd.
- 8. Communico Electronics Sdn. Bhd.
- 9. Conner Peripherals (M) Sdn. Bhd.
- 10. Contraves Advanced Devices Sdn. Bhd.
- 11. Cybron Technology (M) Sdn. Bhd.
- 12. Discomp Magnetics (M) Sdn. Bhd.
- 13. East Coast Electronic Sdn. Bhd.
- 14. Eastrade Electronics (M) Sdn. Bhd.
- 15. Electrical Components Sdn. Bhd.
- 16. FRS (M) Sdn. Bhd.
- 17. Hitachi Metals Electrical (M) Sdn. Bhd.
- 18. GG Circuits Industries Sdn. Bhd.
- 19. Granek Sdn. Bhd.
- 20. Hitachi Semiconductor (M) Sdn. Bhd.
- 21. Innopower Electronics Sdn. Bhd.
- 22. Innopower Keidenki Sdn. Bhd.
- 23. JVC Electronics (M) Sdn. Bhd.
- 24. JVC Video Manufacturing (M) Sdn. Bhd.
- 25. KESP Sdn. Bhd.
- 26. King Musical Ind. Sdn. Bhd.
- 27. Koa Denko (M) Sdn. Bhd.

- 28. Kobe Precision (M) Sdn. Bhd.
- 29. Konsep Ganda Sdn. Bhd.
- 30. Lambang Hidup, Ltd.
- 31. Lemtronics Sdn. Bhd.
- 32. Malaysia Quartz Crystal Sdn. Bhd.
- 33. Marconi (M) Sdn. Bhd.
- 34. Matsushita Electric Co., (M) Bhd.
- 35. Matsushita Electronic Components (M) Sdn. Bhd.
- 36. Matsushita Electronic Devices (M) Sdn. Bhd.
- 37. Matsushita Television Co., (M) Sdn. Bhd.
- 38. Maxtor Sidgapore Ltd.
- 39. Menange Micro-Electronics Sdn. Bhd.
- 40. Meranti Computers Sdn. Bhd.
- 41. Mitsui High-Tec (M) Sdn. Bhd.
- 42. Mitsuoka Electronics (M) Sdn. Bhd.
- 43. Molex (M) Sdn. Bhd.
- 44. Moritetsu Electric (M) Sdn. Bhd.
- 45. Multitone Electronics Sdn. Bhd.
- 46. Naito Electronics (M) Sdn. Bhd.
- 47. National Semiconductor Sdn. Bhd. (Malacca)
- 48. NEC Semiconductors (M) Sdn. Bhd.
- 49. Northern Telecom Components Sdn. Bhd.
- 50. Northern Telecom Industries Sdn. Bhd.
- 51. Northern Telecom (M) Sdn. Bhd.
- 52. Pan International Electronics (M) Sdn. Bhd.
- 53. Penshin Components Sdn. Bhd.
- 54. Pernas NEC Telecommunications Sdn. Bhd.
- 55. Pernas NEC (Kedah) Sdn. Bhd.
- 56. Perwira Ericsson Sdn. Bhd.
- 57. Radiola Corporation (M) Sdn. Bhd.

- 58, Rectron (M) Sdn. Bhd.
- 59. Richwell Indusries Sdn. Bhd.
- 60. Sankyo Seiki (M) Sdn. Bhd.
- 61. Sharp-Roxy Corporation (M) Sdn. Bhd.
- 62. Silver Electronics (M) Sdn. Bhd.
- 63. Siong Export Industries Sdn. Bhd.
- 64. Sony TV Industries (M) Sdn. Bhd.
- 65. South East Asia Carbon & Trading (M) Sdn. Bhd.
- 66. Swilynn (M) Sdn. Bhd.
- 67. Techtrans Systems Sdn. Bhd.
- 68. Thomson Electronic Parts (M) Sdn. Bhd.
- 69. Toshiba Capacitor (M) Sdn. Bhd.
- 70. Transicoil (M) Sdn. Bhd.
- 71. Two-Sanshin (M) Sdn. Bhd.
- 72. Yokowo Electronics (M) Sdn. Bhd.
- 73. Accent Technology Sdn. Bhd.
- 74. Avnet Industries (M) Sdn. Bhd.
- 75. Daimik Electronic Industrial Co., Sdn. Bhd.
- 76. Dai Hwa Industrial Co (M) Sdn. Bhd.
- 77. East Coast Electronic Sdn. Bhd.
- 78. Electronik Okano (M) Sdn. Bhd.
- 79. Epson Precision (M) Sdn. Bhd.
- 80. European (M) Electronics Sdn. Bhd.
- 81. Epson Precision (Johor) Sdn. Bhd.
- 82. Funai Electric (M) Sdn. Bhd.
- 83. G.E. Audio (M) Sdn. Bhd.
- 84. Hitachi Consumer Products (M) Sdn. Bhd.
- 85. I.E.S. Industries Sdn. Bhd.
- 86. J&E (M) Sdn. Bhd.
- 87. Kesm Industries Sdn. Bhd.

- 88. Kyotronics (M) Sdn. Bhd.
- 89. Lucas Automotive Sdn. Bhd.
- 90. Matsushita Precision Industrial Co (M) Sdn. Bhd.
- 91. Micro Base Electronics Sdn. Bhd.
- 92. Microcomputer Systems (M) Sdn. Bhd.
- 93. Mitsumi Electronics (BP) Sdn. Bhd.
- 94. Motorola Semiconductor Sdn. Bhd.
- 95. Multitape Industries Sdn. Bhd.
- 96. Okida Enterprise Sdn. Bhd.
- 97. Omron (M) Sdn. Bhd.
- 98. Omrom (M) Electronics Sdn. Bhd.
- 99. Precima Sdn. Bhd.
- 100. PNE Electric Sdn. Bhd.
- 101. Quality Technologies Electronics (M) Sdn. Bhd.
- 102. Quamac Sdn. Bhd.
- 103. Rohm-Wako (M) Sdn. Bhd.
- 104. Santronics (M) Sdn. Bhd.
- 105. Sapura Holdings Sdn. Bhd.
- 106. S.E.H. (M) Sdn. Bhd.
- 107. SGS-Thomson Microelectronics Sdn. Bhd.
- 108. Singamip Industry Sdn. Bhd.
- 109. Singatronics (M) Sdn. Bhd.
- 110. Tamura Electronies (M) Sdn. Bhd.
- 1 1 1. Technocom Systems Sdn. Bhd.
- 112. Teletron Industries Sdn. Bhd.
- 113. Texas Instruments (M) Sdn. Bhd.
- 114. Todai (M) Sdn. Bhd.
- 115. Toko Electronic (M) Sdn. Bhd.
- 116. Wearnes Electronics (M) Sdn. Bhd.
- 117. Zal Telecommunication Inds. Sdn. Bhd.

- 118. Zenith Electric Co (M) Sdn. Bhd.
- 119. Zenith Transformer Mfg. Sdn. Bhd.
- 120. Fujitsu Component (M) Sdn. Bhd.
- 121. Tru Tech Electronics (M) Sdn. Bhd.
- 122. Asahi Electronics (M) Sdn. Bhd.
- 123. Astec Pekan Sdn. Bhd.

III-4 Results of the Questionnaire Survey in Malaysia

Results of the Questionnaire Survey in Malaysia

1 Outline of firms which respond to the questions

(1) Year of establishment

Period	Response
Befor 1970	4
1971-1978	32
1979-1983	25
1983-1986	22
After 1987	39
NA	1
Total	123

(2) Number of employees

Number of employees	Response
1,000 or over	3 3
Less than 1,000	1 5
Less than 500	48
Less than 100	26
NA	. 1
Total	123

(3)Paid-up Capital

Paid-up Capital	Response
M\$ 10 Million or over	22
Less than M\$ 10 Million	18
Less than M\$ 5 Million	18
Less than M\$ 2.5 Million	62
NA	3
Total	123

(4)Annual turnover

Annual turnover	Řesponse	
M\$ 100 Million or over	1 1	
Less than M\$ 100 Million	33	
Less than M\$ 10 Million	27	
Less than M\$ 1 Million	8	
NA	4.4	
Total	123	

(5)Export ratio

Export ratio	Response
Less than 10%	4
Less than 30%	5
Less than 50%	4
Less than 90%	8
90% or over	66
NA	36
Total	123

(6) Nationality of parent firm

Nationality of parent firm	Response
Japanese	4 5
American & European	23
Other foreign	2 4
Local	25
NA	6
Total	123

(7) Major products

Products	Response
Consumer electronics	26
Industrial electronics	2 4
Electronics components	66
Others	. 6
NA	1
Total	123

2. 1 Problems in Management (Multiple Answers)

	Total		By Scale of Employees			
	Resp.	%	Typel	Type2	ТуреЗ	Type4
Raising funds	16	3.7	0	0	13.6	40.0
Introduction of new technology	25	21.4	18.8	20.0	18.2	28.0
Purchasing of materials	35	29.9	28.1	20.0	31.8	36.0
High rental fees of land and buildings	5	4.3	3.1	0	4.5	8.0
Difficulties in finding personnel	61	52.1	53.1	53.3	54.5	48.0
Severe competition	13	26.5	31,3	13.3	27.3	28.0
Low operating rate	13	11.1	3.1	6.7	13.6	20.0
Others	15	12.8	12.5	33.3	11.4	4.0

Number of employees is more than 1,000. Note: Type 1

Type 2

Number of companies which belong to this type is 33. Number of employees is below 1,000. Number of companies which belong to this type is 15.

Number of employees is below 500. Type 3

Number of companies which belong to this type is 48. Number of employees is below 100. Number of companies which belong to this type is 10.

Type 4

2. 2 Industrial Associations

(1) Entry into industrial associations

	1		By Scale of Employees (%)			
1			Typel		ТуреЗ	
Yes	77	63.1	81.3		62.5	3
No	45	36.9	18.8	40.0	37.5	577

(2) Advantages of entry into industrial associations (Multiple answers)

	Tota	al	By Scale of Employees (%)			
	Resp.	%	Typel	Туре2	Туре3	Type4
Acquisition of marketing information	62	51.7	33.3	35.7	63.0	61.5
Greater bussiness opportunity	17	14.2	9.1	0	15.2	23.1
Stronger negotiating power with government	60	50.0	60.6	71.4	52.2	23.1
Others	21	17.5	21.2	35.7	17.4	3.8
Nothing	10	8.3	12.1	7.1	8.7	3.8
No idea	10	8.3	3.0	0	6.5	23.1

(3) Roll of industrial associations

	Total		By type of product (%)				
	Resp.	%	Туре А	Туре В	Type C	Type D	
Joint purchase of materials	14	11.7	4.0	.3	6.2	20.0	
Sponsoring of exhibition and business conference	51	42.5	48.0	45.8	40.0	40.0	
Supply of information	85	70.8	68.0	79.2	70.8	60.0	
Others	14	11.7	12.0	12.5	10.8	0	
Nothing	8	6.7	8.0	4.2	7.7	0	
No idea	7	5.8	0	4.2	7.7	20.0	

Note: Type A = consumer product manufacturers

Number of consumer product manufacturers is 26.

Type B =industrial product manufacturers

Number of industrial product manufacturers is 24.

Type C = electronics component manufacturers

Number of electronics component manufacturers is 66.

Type D = other electronic product manufacturers

Number of other electronic product manufacturers is 6.

(4) Necessity for a asocciation for electronics industry

	Total		By type of product (%)				
3	Resp.	%	Туре А	Туре В	Type C		
Necessary	97	81.5	88.0	87.5	74.6		
Not necessary	22	18.5	12.0	12.5		0	

2. 3 Quality Control (QC)

(1) Implementation of QC activities

	Т	Total		By size of employees			
	Resp.	%	Type1	Туре2	ТуреЗ	Туре4	
Yes	112	92.6	100.0	93.3	89.6	88.0	
No	9	7.4	0	6.7	10.4	12.0	
No knowledge about QC	0	0	0	0	0	0	

(2) Expected public assistance for QC activities (Multiple answers)

	To	otal	By size of employees			
	Resp.	%	Typel	Type2	Type3	Type4
Seminer concerning QC methods	67	58.3	63.3	40.0	64.4	54.2
On-the-spot guidance	34	29.6	16.7	20.0	40.0	33.3
Supply of QC manuals	58	50.4	46.7	53.3	53.3	45.8
Management staff training in Japan	30	26.1	43.3	26.7	20.0	12.5
Subsidy for the use of QC consultants	35	30.4	23.3	33.3	35.6	29.2
Others	6	5.2	6.7	6.7	2.2	8.3

2. 4 Technical tie-ups

(1) Experiences of technical tie-up or OEM arrengement

	T	Total		By size of employees			
	Resp.	%	Typel	Туре2	ТуреЗ		
Had technical tie-up	29	24.6	17.2				
Had OEM deal	28	23.7	6.9		22.9		
No	70	59.3	75.9	64.3		50.0	

(2) Way of finding a partner in technical tie-up or OEM arrengement

	Total		By size of employees (%			
	Resp.	%	Type1	Туре2	Туре3	Type4
Offer from partner	22	33.8	20.0		42.3	ì
Uncovered by oneself	14	21.5	20.0		19.2	
Introduced by others	15	23.1	10.0	22.2	26.9	25.0
Others	22	33.8	50.0	44.4	23.1	35.0

(3) Use of RICOM

	To	tal	By size of employees (%)				
	Resp.	%	Typel	Type2	ТуреЗ	Type4	
Have knowledge	26	22.2	13.3	35.7	23.4	24.0	
Have no knowledge	88	75.2	83.3	64.3	72.3	76.0	
Have used, and found it effective	2	1.7	0	0	4.3	0	
Have used, but did not lead to contact	4	3.4	3.3	7.1	0	8.0	

(4) Intention to start to produce PC and peripherals (DBy size of employees

	Т	otal	By size of employees (firm)			
	Resp.	%	Typel	Туре2	ТуреЗ	Туре4
Have a concrete plan	18	16.5	2	2	6	7
Have interest	26	23.9	4	2	14	6
Have no interest	65	59.6	23	10	23	9

(4) Intention to start to produce PC and peripherals @By type of product

	Total		By type of product (Firm)				
	Resp.	%	Туре А	Туре В	Type C	Type D	
Have a concrete plan	18	16.5	2	6	10	0	
Have interest	26	23.9	6	5	12	3	
Have no interest	65	59.6	16	8	38	3	

(4) Intention to start to produce PC and peripherals 3By Nationality

	1	otal	By Nationality (Firm)				
	Resp.	%	Туре а	Type b	Туре с	Type d	
Have a concrete plan	18	16.5	5	2	3	8	
Have interest	26	23.9	5	2	11	7	
Have no interest	65	59.6	30	15	6	9	
Total		100.0	46	22	23	25	

Note:Type a= Japanese

Type b= U.S. and European

Type c= Other foreign

Type d= Local

Total number includes companies which did not resposd the question.

(5) Desire for Technical tie-up or OEM arrengement (Multiple answers)

	Ţ	Total		By size of employees (firm)				
	Resp.	%	Typel	Type2	Type3	Type4		
Technical tie-up	16	37.2	2	2	5	7		
OEM arrengement	12	27.9	2	. 1	4	5		
Joint venture with foreign firms	18	41.9	1	2	6	9		
No interest	12	27.9	1	2	8	0		

(5) Desire for Technical tie-up or OEM arrengement (Multiple answers)

	T	otal	В	By Nationality (Firm)			
	Resp.	%	Туре а	Type b	Туре с	Type d	
Technical tie-up	16	37.2	1	0	6	8	
OEM arrengement	12	27.9	0	1	6	4	
Joint venture with foreign firms	18	41.9	4	0	3	11	
No interest	12	27.9	4	3	4	1	

[★]One company whose nationality is unknown desires technical tie-up and OEM arrengement.

3. Human Resource Development

3. 1 Labour situation

(1) Present employment in production department by type of workers and
by academic back ground
Unit:Person

and the second s	System Engine er	Progra mmer	Engine er	Techin cian	Super- Visor	Skille d work er	Simple worker	Total
Primary School	0	0	0	5	3	455	1861	2324
Lower Secondary School	3	3	1	148	63	9712	19119	29049
Upper Secondary School	1	11	8	355	708	9301	14358	24742
Polytechnic	4	3	129	973	208	157	19	1493
University	23	38	604	126	202	4	33	1030
Vocational Training Institutions	0	11	66	1031	356	585	43	2092
Total	31	66	808	2638	1540	20214	35433	60730

^{*}The figures above are sums of workers who work for responding firms at Nov. 1989. The number of firms which respond to this question is 101.

3. 2 Labour demand

(1) Present shortage of Labour

	Response (A)	(A)/(B)
Serious problem	19	16.0%
Somewhat a problem	6 9	58.0%
Not a problem	3 1	26.1%

^{*(}B); Total number of firms which respond to this question.

(2) Present shortage of labour by type of worker

	Total	Serious problem	Somewhat a problem	Not a problem
Engineer	4.9	18	33	8
Technician	65	19	4 5	12
Supervisor	4 1	4	37	19
Line worker	58	18	3 9	1 6
R&D Personnel	32	13	19	. 5
System Engineer	27	6	21	5
Programmer	22	6	16	12
Manager	23	3	22	18
Salesperson	1 1	6	6	24
Clerical worker	12	0	1 1	37

(3) Future shortage of labour by type of worker (in five years)

Unit:firm

	Total	Very insufficient	Somewhat insufficient	Sufficient
Engineer	63	20	43	20
Technician	83	23	58	16
Supervisor	4 5	10	35	29
Line worker	75	23	52	18
R&D Personnel	4 3	18	23	20
System Engineer	3 0	8	22	23
Programmer	27	8	18	27
Manager	25	6.	19	39
Salesperson	1 5	6	8	3 5
Clerical worker	1 4	3	12	53

3. 3 Future labour demand
(1) Future employment in production department by type of workers and by academic back ground (In five Years) Unit:Person

Aller yang person di dan di senggi Marin Salar di Albanda di Alban	System Engine er	Progra mmer	Engine er	Techin cian	Super- Visor	Skille d work er	Simple worker	Total
Primary School	0	0	0	0	0	0	1290	1290
Lower Secondary School	0	0	0	12	0	2881	12041	14934
Upper Secondary School	0	2	0	19	241	2628	7911	10801
Polytechnic	0	13	35	618	511	217	183	1577
University	45	44	312	56	110	0	20	587
Vocational Training Institutions	5	1	4	343	96	235	215	899
Total	50	60	351	1048	958	5961	21660	30088

^{*}The figures above are sums of workers whom responding firms wish to employ in coming 5 years. The number of firms which respond to this question is 79.

(2) New employment plan

	Response (A)	(A) /(B)
Has a plan for within 1 year	4 5	42.1%
Has a plan for 1-3 years	4 1	38.3%
Has a plan for 3-5 years	7	6.5%
Has a plan for over 5 years	1 4	13.1%

[★](B);Total number of firms which respond to this question.

3. 4 Evaluation of level of new graduates by institution
(1) Evaluation of level of new graduates by institution
Score: A Sufficiently Satisfies the company's requirements.
B Almost meets the company's requirements.
C Is somewhat below the company's requirements.
D Is far below the company's requirements. Unit: %

	A	В	С	D
Primary School	28.9	15.8	22.4	32.9
Lower Secondary School	28.4	37.5	29.5	4.5
Upper Secondary School	37.5	44.2	18.3	0
Polytechnic	22.8	57.4	17.8	2.0
University	32.7	43.6	18.8	5.0
Vocational Training Institutions	20.6	51.0	26.5	2.0

^{*}Figuers above: Response / total number of firms which respond to this question.

3. 5 Needs for the expansion of education and training institutions (1) Needs for the expansion of education and training institutions by Unit:firm subject. (Multiple answers)

Institution Subject	Upper Secondary School	Polytechnic	Universities
Electricity	23	57	33
Electronics	33	8 9	61
Information science	4 1	5 4	62
Communica- tion	` 13	4 1	43
Mechanical	2 1	67	4.8
Chemistry	15	18	29
Metal work	17	3 9	1 3
Management	8	2 4	67
Others	5	8	12
Department of science and mathematics	23	15	18
Others	8	4	6

3. 6 In-house Training(1) Impementation of in-house Training

	Response (A)	(A)/(B)
Has an in-house training system	95	79,8%
Has not an in-house training system	24	20.2%

*(B); Total number of firms which respond to this question.

(2) Ways of Training by type of worker (Multiple answer)

garanteen een een een een een een een een ee	ОЈТ	Seminar within company	Outside training institutions		Others
General worker	91	1 5	0	6	0
Supervisor	55	38	38	39	2
Technician	69	26	29	38	4
Engineer	42	18	33	54	6
Programmer	30	16	3 1	23	4
System Engineer	19	13	19	22	4

*OJT ;On the job training

(3) Evaluation of own in-house training system

	Response (A)	(A)∕(B)		
Enough	48	50. 5%		
Not enough	47	49.5%		

*(B); Total number of firms which respond to this question.

Insufficient field in present training system (Multiple answer)

	Response(A)	(A)/(B)
Training period	1 4	29.8%
Content and level of training	23	48.9%
Size of employees to be trained	16	34.0%
Facilities and materials	26	55.3%
Others	4	8.5%

*(B); Total number of firms which respond to this question.

3. 6(4) Major problems in in-house training (Multiple answers)

Problem area	Response(A)	(A)/(B)
Supervisors are too busy and do not have enough time to give training.	50	58.1%
Training Manuals are not prepared.	20	23.3%
Lack of well-organized training system.	38	44.2%
Instructors are not trained within a company	20	23.3%
Lack of budget.	13	15.1%
Trainees are not motivated to receive training.	13	15.1%
The levels of trainees vary widely.	23	26.7%
It's difficult to invite outside lecturers.	6	7.0%
Outside training institutions do not prepare appropriate curricula.	16	18.6%
Outside training institutions receive a limited number of trainees.	1	1.2%
Outside training institutions hold insufficient equipment, materials and instractoes.	8	9.3%
There is no training institution near the company.	16	18.6%
Others	9	10.5%

 $\boldsymbol{*}(B);$ Total number of firms which respond to this question.

(5) Expansion plan of in-house training

	Response(A)	(A)/(B)
Has an expansion plan	70	76.9%
Has not an expansion plan	21	23.1%

*(B); Total number of firms which respond to this question.

(6) Reasons for not having an in-house training system (Multiple answer)

	Response(A)	(A)/(B)
Not necessary	3	13.6%
Lack of budget	7	31.8%
Lack of know-how and instractors	1 1	50.0%
Others	4	18.2%

*(B); Total number of firms which respond to this question.

(7) Plan to start in-house training

	Response(A)	(A)∕(B)
Has a plan	8	36.4%
Has no plan	14	63.6%

*(B);Total number of firms which respond to this question.

3. 7 Use of outside training institutions

(1) Use of outside training institutions (Multiple answer)

	Using	Once used but not now	Never used	Do not know
MARA vocational training institution	5	5	47	6
CIAST	7	5	42	1 3
Industrial training institutions	10	7	42	7
NPC	35	1 4	32	4
MIDEC	3	О	42	12
Others	38	2	17	6

(2) Evaluation of outside training institutions (Multiple answer)

	Useful	Somewhat useful	Useless	Do not know the institu- tion well
MARA vocational training institution	9	26	0	36
CIAST	12	12	0	50
Industrial training institutions	15	29	1	32
NPC	29	4 5	1	22
MIDEC	5	10	1	4 4
Others	23	13	О	18

(3) Necessity for expansion of training institutions by institution (Multiple answer)

	Very important	Somewhat important	Not important	Bo not know the institu- tion well
MARA vocational training institution	38	2 4	1	3 0
CIAST	1 8	18	1	47
Industrial training institutions	38	29	0	29
Youth training centers	16	27	5	33
Ministry of welfare services' training centers	6	21	4	43
NPC	45	3 3	1	19
MIDEC	6	1 4	1	43
Others	6	5	1	12

(4) Necessity for expansion of training institutions by technology (Multiple answer)

	General worker	Supervisor	Technician
Macine operation	43	23	29
Die Making	1 4	20	37
Forging	9	7	1 3
Welding	13	1 0	20
Metal fabrication	15	14	23
Press work	16	1 0	1 5
Foundry and casting	1 7	9	1 3
Rubber moulding	13	1 0	12
Plastic moulding	16	22	21
Electrical Engineering	1 1	35	67
Electronics Engineering	1 1	53	8 8
Instructor and supervisor training	5	74	31
Plant engineering	3	4 1	36
Quality control	39	86	62
Computer science	4	4 4	4 1

3. 8 Necessity for establishing a public-private-joint training institution

(1) Necessity for establishing a public-private-joint training institution \cdot

	Response(A)	(A)∕(B)
Necessary	1 1 0	91.7%
Not necessary	1 0	8.3%

*(B); Total number of firms which respond to this question.

(2) Intention to send employees to the public-private-joint training institution

	Response(A)	(A)/(B)
Has intention	107	91.5%
Has no intention	1 0	8.5%

*(B):Total number of firms which respond to this question.

(3) Expected type of training in the public-private-joint training institution (multiple answer)

	Response(A)	(A)/(B)
Training of general workers	28	23.7%
Training of supervisors	9 1	77.1%
Training of technicians	102	86.4%
Training of engineers	5 9	50.0%

*(B);Total number of firms which respond to this question.

(4) Intention to cooperate to the public-private-joint training institution

	Response(A)	(A)/(B)
Has intention	87	79.1%
Has no intention	23	20.9%

*(B); Total number of firms which respond to this question.

Possible types of cooperation to the public-private-joint training institution (Multiple answer)

y de Challes la describe de la companie de companie de la companie	Response(A)	(A)/(B)
Dispach of instractors	45	36.6%
Provision of machinery and equipment	17	13.8%
Offering of building	2	1.6%
Provision of funds	28	22.8%

*(B); Total number of firms which respond to this question.

3. 9 Incentive for trainings

(1) Use of Incentive for trainings

	Response(A)	(A)/(B)
Using	1 1	9.4%
Not using	106	90.6%

*(B);Total number of firms which respond to this question.

(2) Problem in incentive for trainings (Multiple answer)

	Response(A)	(A)/(B)
Small benefit from incentive	14	14.9%
Complicated formalitiies	20	21.3%
Narrow eligibility for incentive	16	17.0%
Little knowledge of the incentive	55	58.5%
Others	9	9.6%

*(B); Total number of firms which respond to this question.

4 Financing

4. 1 Fund raising

(1) Uses of funds recruited in the past two years

	Responses	Percentage (%)
Working capital	52	60.5
Construction of new plant	48	55.8
Modernisation of facilities	35	40.7
Setting-up of branch offices	6	7. 0
Product development	20	23.3
Business diversification	10	11.6
Making-up for loss	1 0	11.6
Others	1 1	12.8

(2) Funds sources in the past two years

	Responses	Persentage (%)
Borrowing	5 9	81.9
(From lenders in Malaysia) Public financial institutions	19	(32. 2)
Private financial institutions	26	(44.1)
Private companies and persons	3	(5.1)
Parent or related companies	6	(10.2)
(From lenders overseas) Financial institutions	3	(5.1)
Parent or related companies	19	(15.4)
Others	3	(5. 1)
Lease	1 3	18.1
Issuance of stock	15	12.2

(3) Uses of funds recruited in the coming two years

	Responses	Percentage (%)
Working capital	53	63.9
Construction of new plant	43	51.8
Modernisation of facilities	39	47.0
Setting-up of branch offices	4	4.8
Product development	3 1	37.3
Business diversification	1 7	20.5
Making-up for loss	3	3.6
Others	4	4.8

(4) Funds sources in the coming two years

	Responses	Percentage (%)
Borrowing	7 1	88.8
(From lenders in Malaysia) Public financial institutions	26	(37.1)
Private financial institutions	27	(38.6)
Private companies and persons	3	(4.3)
Parent or related companies	8	(11.4)
(From lenders overseas) Financial institutions	5	(7. 1)
Parent or related companies	2 4	(34.3)
Others	0	(0)
Lease	12	9.8
Issuance of stock	10	12.5

4. 2 Problems in funds raising

(1) Difficulties in funds raising

	Responses	%
Very difficult	1 1	11.3
Somewhat difficult	36	37.1
Easy	50	51.5

(2) Reasons for difficulty in fund raising

	Responses	Percentage (%)
Severe loan eligibility	7	15,6
Collateral for a loa is required	26	57.8
Gurantee of the parent company is required	12	26,7
Much time for screening	1 0	22.2
Borrowing procedures are troblesome	1 3	28.9
Loan amount is limited	17	37.8
High interest rate	1 6	35.6
High exchange risk	7	15.6
Undeveloped stock market in Malaysia	1	2. 2
Lack of access to the international financial market	8	17.8
Lack of financing know-how in the company	1	2. 2
Others	1	2. 2

4.3 Use of CGC

(1) Use of CGC

	responses	%
Using	4	3.8
Once used, but not now	5	4.8
Never used	96	91.4

Examined the use of CGC

	Responses	%
Yes	11	13.3
No	72	86.7

Having a plan to use CGC

	Responses	%
Yes	13	19.1
No	55	80.9

(2) Wish the expansion of CGC scheme

	Responses	%
Yes	4 4	66.7
No	22	33.3

(3) Problems in CGC scheme

	Responses	%
Complicated formalities	6	8.6
Loan amount is small	1 1	15.7
Severe lending conditions	4	5.7
Additional collateral is required	6	8.6
Eligible firms are limited to SMI	16	22.9
Lack of knowledge of the scheme	46	65.7
Others	1	1.4

(4) Importance of financial facilities for small & medium-scale industry

	Responses	%
Very important	5 3	59.6
Somewhat important	28	31.5
Not important	8	9.0

- 4. 4 Financial support system for long-term investment
- (1) Necessity for financing scheme for long-term investment by electronics industry

	Responses	%
Very necessary	56	54.9
Somewhat necessary	40	39.2
Not necessary	6	5.9

(2) Expected lending conditions ①Expected interest rate

Interest rate	Responses
Below 3.5 %	4
Below 5.0 %	26
Below 7.0 %	12
More than 7.0 %	5
NA	76

@Expected lending terms

Terms	Responses
1 year ≦ 3 years	1
3 years ≦ 5 years	3
5 years ≤ 7 years	23
7 years ≤ 9 years	3
9 years ≦ 15 years	17
More than 15 years	7
NA	69

Sexpected maximum loan amount

Maximum lean amount	Responses	
M\$15 thousant - M\$50 million	47	
M\$50 million - M\$100 million	2	
M\$450 million - M\$500 million	1	
NA	73	

- 5 Promotion of parts industry
- 5. 1 Problems Concerning Management
- (1) Managerial Problems Pointed Out by Parts Makers

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	6	4
Procurement of funds	6	1	_	3	2	-
Introduction of new technology	14	5	3	4	2	· <u></u>
Purcahse of materials	17	10	4	3		-
High rental fees of land and building	2	_	_	_	2	-
Difficulty in finding personnel	33	11	6	9	4	3
Severe competition	17	8	2	6	1	_
Low operation rate	5	2		2	1	
Others	11	1	7	1	1	1
N.A.	4	2	1	1	-	-

(2) Problems of Parts Makers Pointed Out by Customers

(No. of Companies Answered)

nan oleh sekenya maken dalah makamat Samban termana oleh Mandra Bash dalah dalah dalah dalah dalah dalah dalah	Consumer Electronics Maker	Industrial Electronics Makers
Total	26	24
Lack of Long-term outlook on management	5	6
Lack of interest in improving quality	9	7
Lack of product develop- ment and improvement capabilities	15	12
Lack of knowledge on business practices etc.	_	2
Lack of marketing capabilities	2	6
Lack of engineers	7	6
N.A.	4	2

5. 2 Procurement of Materials

(1) Present Local Contents of Electronics Companies in Malaysia (No. of Company Answered)

<u>er en </u>	Local contents at present	Local contents in five years (Estimate)
Less than 10%	2 1	6
10~20%	15	1 0
20~50%	3 4	1 9
50~80%	23	3 9
More than 80%	6	23
N.A.	2 4	26
Total	123	123

(2) Changes in Local Parts Procurement Rate

(No. of Company Answered)

(Parts Makers)	Total		European Company	OtherForeign Company	Local Company	N.A.
Have grown considerably.	8	4	2	1	1	
Have grown slightly.	29	15	4	7	1	2
Have not changed much.	22	9	7	4	1	1 .
Have fallen due to quality problem.	-		-	<u></u>		_
N.A.	7	1	1	1	3	1

(3) Policy toward Increase in Local Procurement Rate

(No. of Company Answered)

(Parts Makers)	Total		European Company	OtherForeign Company	Local Company	N.A.
Very positieve	13	3	4	5	1	-
Desire to increase purchase if conditions are met	40	22	8	6	2	2
Satisfied wirh current state	3	1	_	2		-
Not particularly interested at present	5	3	1	-		1
N.A.	5	~	1		3	1

(4) Assistant to Local Parts Makers

(No. of Company Answered)

(Parts Makers)		Japanese Company	European Company		Local Company	N.A.
Total	66	29	14	13	6	4
Provide assistance.	38	19	10	7	-	2
Do not provide assistance.	23	10	3	6	3	1
N.A.	5	-	1	_	3	1

(5) Types of Assistance to Parts Makers

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Technical assistance for the improvement of products' quality or the guidance in QC	37	20	10	5	-	2
Assistance in training	7	3	2	1		1
Financial assistance	2	2	_	-		
Provision of materials	10	6	2	1		1
Provision of machinery or other production facilities	5	3	2	-	_	
Introduction of new customers	5	1	1	3	_	_
Others	2	1	1		-	_
N.A.	24	7	3	6	6	2

(6) Problems of Local Parts Makers

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Lack of long-term outlook on management	17	10	3	3	~~	1
Lack of interest in improving quality	26	15	2	6	3	-
Lack of product develop- ment and improvement capabilities	36	17	10	7	1	1
Lack of knowledge on business practices etc.	4	3	-	-	1	_
Lack of marketing capabilities	7	3	2	2	-	_
Lack of engineers	7	4	1	2	_	
N.A.	11	1	2	2	3	3

(7) Methods to Fing Local Parts Suppliers

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Sales efforts by suppliers	35	17	9	7	1	1
Word of mouth communi- cation among persons in the same industry	21	9	3	7	-	2
Business contacts at head office	9	4	1	2	1	1
Directories and other publications	35	12	10	10	1	2
Introduction from the third parties/persons	20	10	3	6	1	–
N.A.	6	-	2		3	1

(8) Effective Method for Improving Local Procurement Ratio

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Offering incentives for use of domestic parts	32	13	6	10	2	1
Guidance in quality control for local parts manufacturers	44	22	8	11	· _	3
Promotion of investment in Malaysia by foreign affilicated parts manufacturers	24	10	6	6	1	1
Arrangement of infor- mation regarding dome- stic parts manufacturers	16	5	1	9	1	
Import restrictions on parts by country of origin	4	3		1		_
Others	2	_	2	_	_	-
N.A.	6		2	_	3	1

5. 3 Quality Control

(1) Existance of Quality Control Activity

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	- 6	4
Exists.	62	26	13	13	6	4
Does not exist.	3	2	1		-	1
N.A.	1	1	_	_	_	-

(2) Measures Intended to be Taken in the Future for the Improvement of Quality (No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	6	4
Seminar concerning QC method	33	13	7	8	2	3
On-the-spot guidance by specialists visiting each factory	16	4	1	7	3]
Supply of QC manuals	35	16	5	9	2	3
Training by dispatching the management staff to Japan	22	16	1	2	2	1
Subsidy for the use of QC consultants	15	5	5	3	_	2
Others	3	_	3	_	_	_
N.A.	4	2	1	1		-

5. 4 Securing of Labour Force

(1) Situation of Shortage of Labour Force

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	. 29	14	13	6	4
lt is a serious problem.	8	4	_	1	2	1
lt is somewhat a pro- blem.	41	18	9	9	3	2
lt is not a problem.	15	5	5	3	1	1
N.A.	2	2	-	-		_

(2) Types of Workers Insufficient

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	. 13	6	4
Engineer	26	10	7	8	-	1
Technician	35	14	6	8	4	3
Supervisor, Foreman	23	10	4	4	2	3
Production Line Worker	38	16	6	10	5	1
R&D Personnel	14	6	4	3	1	_
System Engineer	13	6	3	4	_	_
Programmer	12	9	1	1	_	1
Manager	14	6	5	2	-	1
Salesperson	3		2		1	_
Clerical Worker	5	2	2	1	_	_

5. 5 Personnel Development

(1) Existance of In-house Training

(No. of Company Answered)

(Parts Makers)	Total		European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	6	4
Have an in-house train- ing system.	54	26	14	10	3	1
Do not have an in-house training system.	12	3		3	3	3
N.A.	-	_	_	_		_

(2) Situation of In-house Training

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Сопрапу	N.A.
Total	66	29	14	13	6	4
Give enough training	29	16	9	2	2	_
Do not give enough training.	25	10	5	8	1	1

	-					·····
(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	6	4
Supervisors are busy and do not have enough time to give training	30	14	7	4	2	١
Training manuals are not prepared.	12	9	2	1	_	
Lack of well-organized training system and planning.	20	9	6	4	1	_
Instructors are not trained within the company.	10	6	3	1	••	Amb
Lack of budget	4	1	2	1	_	-
Trainees are not motivated to receive training.	7	3	2	1		1
The levels of trainees vary widely.	12	5	2	4	_	1
It is difficul to invite outside lecturers and instructors.	6	2	3	1		•
Outside training institutions do not prepare appropriate curricula.	12	2	7	3	-	
Outside training institutions receive a limited number of trainees.	1	1	_	-	_	_
Outside training institutions hold insufficient equipment, materials and instructors.	6	1	4	2	-	<u></u>
There is no training institution near the company.	11	5	3	-	1	-
Others	5	2	3	_	_	-

5. 6 Fund Raising

(1) Difficulty in Raising Fund

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	6	4
Very difficult	3	-	_	2	1	-
Somewhat difficult	20	6	5	5	-1	3
Easy	29	18	5	5	1	
N.A.	14	5	4	1	3	1

(2) Reasons of Difficulty in Raising Fund

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	6	4
Severe Loan eligibility	4	1	-	3	-	-
Financial institutions require collateral for a loan.	11		1	6	2	2
Financial institutions require guarantee of the parent company.	7	2	3	2	-	-
Financial institutions take much time for screening.	2	<u>.</u>	~~	1	-	1
Troublesome formalities of borrowing procedures	6	1	2	1	1	1
Loan amount is limited.	6	1	1	3	1	_
High interest rate	8	2	-	2	2	2
Exposure to exchange risk	5	2	2	1	_	
Undeveloped stock market in Malaysia	_		_	_	-	_ :
Lack of access to the international financial market	3	3	-		-	
Company's financial manager is poor in know-how of financing.	1		-	_		1
Others	_	_	_		_	-

5. 7 Marketing

(1) Problems of New Market Development

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	6	4
Lack of marketing information	22	10	5	5	1	I
Lack of business talks and other opportunities for business expansion	6	4	-	2		
Lack of information on business practices, etc.	5	2	1	1	1	<u>-</u> -
Severe requirement on the level of technology and product quality.	12	6	1	5	_	-
Others	7	4	I	1	-	1
N.A.	24	7	7	4	4	2

(2) Experience in Paticipating in Exhibitions

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company	Company	OtherForeign Company	Сопрану	N.A.
Total	66	29	14	13	6	4
Yes, domestically.	9	7	_	2	-	-
Yes, overseas as well.	13	6	4	2	-	1
No experience.	30	13	5	7	3	2
N.A.	14	3	5	2	3	1

(3) Wish to Participate in Exhibitions

(No. of Company Answered)

(Parts Makers)	1	ē .	European Company	OtherForeign Company	Local Company	N.A.
Total	66	29	14	13	6	4
Yes, domestically.	13	6	2	2	1	2
Yes, overseas as well.	18	7	2	8	1	_
Not interested.	20	13	5	-	1	1
N.A.	15	3	5	3	3	1

(4) Reasons of not Interested in Exhibitions

(No. of Company Answered)

(Parts Makers)	Total	Japanese Company		OtherForeign Company	Local Company	N.A.
Total	66	29	14	. 13	6	4
Have hands full with current orders at present	7	5	1	-	1	4.61
Difficult to cover expenses.			_		**	
Not expected much in terms of results.	8	6	1	_	_	1
Others	5	2	2	_		1
N.A.	1	-	1			<u></u>

6 Expectations for government supports

	Responses	%
Expansion of vocational training schools	45	40.5
Review of curricula at vocational schools	37	33.3
Establishment of politechnics in local areas	24	21.6
Review of curricula at politechnics	3 4	30.6
Expansion of electronics courses at universities	52	46.8
Establishment of university-industry joint R&D system	49	44.1
Establishment of government-private sector vocational training organisations	47	42.3
Simplification of procedurers for loans from financing organisations	45	40.5
Establishment of long-term investment funds for new investment	4 0	36.0
Introduction of low interest rate financing scheme for small and medium-scale firms	46	41.4
Expansion of CGC Scheme	7	6.3
Preparation of domestic parts manufacturers directory	63	56,8
Improvement of MEXPO's inquiry services and strangthening of its activities for development of overseas markets	19	17.1
Holding of exhibisions and business talks for electronics parts and subsidies for participation	3 4	30.6
Subsidies for the utilisation of management consultants by small & medium-scale firms	23	20.7
Holding of managenment seminars for small & medium-scale firms	15	13.5
Support for QC activities at domestic parts manufacturers	66	59.5
Creation of inspection system for quality improvement of domestic parts	53	47.7
Expansion of MIDA services for introduction of partners for technological tie-ups/OEM agreement	3 7	33.3
Supply of subsidies for R&D activities and review of tax incentives	5 1	45.9
Creation of public sector research institutes for electronics	43	38.7
Establishment of high-tech industrial estates for electronics industry	62	55.9
Incentives for support of subcontractors by assembly manufacturers	47	42.3
Review of MTI's subcontracting scheme	8	7.2

Note: Percentage = Responses / Total number of respondents

III-5 List of the U.S. Computer-related Manufacturers which were Objects of the Telephone Interviews

List of the U.S. Computer-related Manufacturer which were objects of the Telephone Interviews $1\,\diagup\,3$

•		
Company	Address	TEL
1.Amdek Corporation	3471 N.First Street, San Jonse CA 95134	408-436- 8570
2.AST Research Inc.	2121 Alton Avenue Irvine, CA 92714	714-863- 1333
3.AT&T Data Systems Group	1 Speedwell Avenue Morristown, NJ 07962	800-247- 1212
4. Apple Computer, Inc.	20525 Mariani Avenue Cupertino, CA 95014	408-996- 1010
5.Atari Corporation	1196 Borregas Avenue Sunnyvale, CA 94088	408-745- 2000
6.BULL HN Information Systems, Inc.	300 Concord Road Billerica, MA 01821	617-671- 6000
7.Commodore Business Machines	1200 Wilson Drive West Chester, PA 19380	215-431- 9100
8.Compaq Computer Corporation	20555 FM D149 Houston,TX 77070	713-370- 0670
9.ComputerLand Corporation	30800 Santana Street Hayward, CA 94544	415-734- 4000
10.Dell Computer Corporation	9505 Arboretum Blvd. Austin, TX 78759	512-338- 4400
11.Data General Corporation	4400 Computer Drive Westboro, MA 01580	508-366- 8911
12.Digital Equipment Corporation	146 Main Street Maynard, MA 01754	617-493- 5350
13.Everex Computer Systems Division	48431 Milmont Drive Fremont, CA 94538	415-498- 1111
14.GRiD Systems Corporation	47211 Lakeview Box 5003 Fremont, CA 94537-5003	415-656- 4700
15. Hewlett-Packard Company	3000 Hanover Street Palo Alto, CA 94304	415-857- 1501
16.IBM Corporation	Old Orchard Road Amonk, NY 10504	914-765- 1900
17. Kaypro Corporation	533 Stevens Avenue Solano Beach, CA 92075	619-481- 4300

Company	Address	TEL
18. Leading Edge	225 Tumpike Street Canton, MA 02021	617-828- 8150
19. Memorex Telex Corporation	4343 S. 118th East Avenue Tulsa, OK 74146	918-627- 1111
20.NCR Corporation	1700 South Patterson Blvd. Dayton, OH 45479	513-445- 5000
21. Tandon Computer Corporation	405 Science Drive Moorpark, CA 93021	805-523- 0340
22. Tandy Corporation	1800 One Tandy Center Ft. Worth, TX 76102	817-390- 3011
23.TeleVideo Systems, Inc.	550 East Brokaw Road P.O. Box 49048 San Jose, CA 95161-9048	408-954- 8333
24.Texas Instruments, Inc.	13500 N. Central Expressway Dallas, TX 75265	214-995- 4855
25.Unisys Corporation	P.O. Box 500 Blue Bell, PA 19424	215-542- 4011
26.Victor Technologies	395 Phoenixville Pike Malvern, PA 19355	215-251- 5000
27.Wang Laboratories, Inc.	One Industrial Avenue Lowell, MA 01851	617-459- 5000
28. Wyse Technology	3571 North First Street San Jose, CA 95134	408-433- 1000
30.Zenith Data Systems	1000 Milwaukee Avenue Glenview, IL 60025	312-699- 4800
31. AREAL TECHNOLOGY, INC.	3050 Scott Boulevard Santa Clara, CA 95054	
32.BRAND TECHNOLOGIES, INC.	9559 Irondale Avenue Chatsworth, CA 91311	
33.CARDIFF PERIPHERALS CORPORATION	5421 Avenida Encinas Carlsbad, CA 92008	
34.COMPORT CORPORATION	734 Sycamore Drive Milpitas, CA 95035	
35. CONNER PERIPHERALS, INC.	2221 Old Oakland Road San Jose, CA 95131	
36.IMPRIMIS TECHNOLOGY INCORPORATED Subsidiary of Control Data Corporation	8100-34th Avenue South Minneapolis, MN 55440	

Company	Address	TEL	
38.INTERNATIONAL BUSINESS MACHINES CORPORATION	Route 22 Armonk, NY 10504		
39. JOSEPHINE COUNTY TECHNOLOGY	1899 N.W. Hawthorne Grants Pass, OR 97526		
40.KALOK CORPORATION	1287 Anvilwood Avenue Sunnyvale, CA 94089		
41.LAPINE TECHNOLOGY CORPORATION	182 Topaz Avenue Milpitas, CA 95035		
42. MAGNUM TECHNOLOGY CORPORATION Subsidiary of Danbus Memory Systems, Inc.	5630B Kearney Mesa Road San Diego, Ca 92111		
43. MAXTOR CORPORATION	150 River Oaks Parkway San Jose, CA 95134		
44.MICROPOLIS CORPORATION	21123 Nordhoff Street Chatsworth, CA 91311		
45.MICROSCIENCE INTERNATIONAL CORPORATION	305 North Mathilda Avenue Sunnyvale, CA 94086		
46.MILTOPE CORPORATION	1770 Walt Whitman Road Melville, NY 11747		
47.MINISCRIBE CORPORATION	1871 Lefthand Circle Longmont, CO 80501		
48.PLUS DEVELOPMENT CORPORATION Subsidiary of Quantum Corporation	1778 McCarthy Boulevard Milpitas, CA 95035		
49. PRIAM CORPORATION	20 West Montague Expressway San Jose, CA 95134		
50.QUANTUM CORPORATION	1804 McCarthy Boulevard Milpitas, CA 95035		
51.SEAGATE TECHNOLOGY	920 Disc Drive Scotts Valley, CA 95066		
52.TANDON CORPORATION	20320 Prairie Street Chatsworth, CA 91311		
53.WESTERN DIGITAL CORPORATION	2445 McCabe Way Irvine, CA 92714		
54. XEBEC	3579 Highway 50 East Carson City, NV 89701		

III-6 List of Member Companies of JEIDA

List of Member Companies of JEIDA

- 1. Aitech Co,. Ltd.
- 2. Asahi Glass Co., Ltd.
- 3. Asia Electronics Ind. Co., Ltd.
- 4. Advantest Co..
- 5. Alps Electric Co., Ltd.
- 6. Ando Electric Company Ltd.
- 7. Anritsu Co,.
- 8. Iwatsu Electric Co.. Ltd.
- 9. Okura Electric Co.. Ltd.
- 10. Osaka Titanium Co.. Ltd.
- 11. Oki Electric Ind. Co., Ltd.
- 12. Oki-Unisys Co,. Ltd.
- 13. Casio Computer Co., Ltd.
- 14. Canon Inc.
- 15. Kubota Computer Co,. Ltd.
- 16. Graph-Tech Co., Ltd.
- 17. Kokusai Electric Co., Ltd.
- 18. Copal Electronics Co,. Ltd.
- 19. Komatsu Electronics Co., Ltd.
- 20. Sanyo Electric Co., Ltd.
- 21. SPC Electronics Co..
- 22. Shimazu Co..
- 23. Shaken Co., Ltd.
- 24. Sharp Co,.
- 25. Juki Co,. Ltd.
- 26. Showa Information Equipment Co., Ltd.

- 27. Shinetsu Semiconductor Co., Ltd.
- 28. Shinko Co,. Ltd.
- 29. Shinko Electric Co.. Ltd.
- 30. New Japan Radio Co.. Ltd.
- 31. Sumitomo Electric Ind. Ltd.
- 32. Seiko Epson Co,.
- 33. Seikoshya Co,.
- 34. Seiko Instruments Inc.
- 35. Sord Co,.
- 36. Sony Co,.
- 37. Daikin Ind. Co,.
- 38. Omron Tateishi Electronics Co,.
- 39. Tamura Electric Works Ltd.
- 40. Chino Co,.
- 41. Chuo Electronics Co,. Ltd.
- 42. Teac Co,.
- 43. Teikoku Tsushin Kogyo Co,. Ltd.
- 44. TDK Co,.
- 45. Densan Co,. Ltd.
- 46. Tokyo Applied Chemistry Ind. Co..
- 47. Tokyo Cathode Research Institute Co,.
- 48. Tokyo Meter Co,. Ltd.
- 49. Tokyo Tatsuno Co,. Ltd.
- 50. Tokyo Electric Co,.
- 51. Totoku Electric Co,. Ltd.
- 52. Tokiko Co...
- 53. Tokin Co,.
- 54. Toko Inc.
- 55. Toshiba Co,.

- 56. Toyo Communication Equipment Co., Ltd.
- 57. Tore Engineering Co..
- 58. Shinnichi Electric Co,. Ltd.
- 59. Nitettsu Electronics Co., Ltd.
- 60. Nippon Avionics Co., Ltd.
- 61. Nippon Glass Co,. Ltd.
- 62. Nippon kohden Co..
- 63. Nippon Silicon Co,.
- 64. Nippon Signal Co..
- 65. Data General Japan Co..
- 66. NEC Co,.
- 67. NEC Office Systems Co..
- 68. Nippon Electric Ind. Co., Ltd.
- 69. NEC Home Electronics Ltd.
- 70. Nippon Denso Co,. Ltd.
- 71. Victor Co.. of Japan Ltd.
- 72. Japan Business Computer Co., Ltd.
- 73. Japan Minicomputer Systems Co..
- 74. Japan Radio Co., Ltd.
- 75. Japan Mectrom Co.. Ltd.
- 76. Hitachi Ltd.
- 77. Hitachi Maxell Ltd.
- 78. PFU Co...
- 79. Fanac Ltd.
- 80. Fuji Xerox Co,.
- 81. Fujisoku Electric Co.. Ltd.
- 82. Fujitsu Ltd.
- 83. Fujitsu Isotech Co,. Ltd.
- 84. Fuji Electric Co,. Ltd.

- 85. Fuji Facom Co,. Ltd.
- 86. Furukawa Electric Co,. Ltd.
- 87. Hokuriku Electric Ind. Co,. Ltd.
- 88. Hoya Co,.
- 89. Matsushita Communication Industrial Co., Ltd.
- 90. Matsushita Electric Industrial Co.. Ltd.
- 91. Matsushita Electric Works Ltd.
- 92. Marcon Electronics Co,. Ltd.
- 93. Mitsubishi Electric Co,.
- 94. Murata Manufacturing Co., Ltd.
- 95. Meidenshya Co,.
- 96. Yasukawa Electric Co,.
- 97. Yamatake Honewell Co..
- 98. Yamaha Co,. Ltd.
- 99. Yokogawa Electric Co,.
- 100. Yokogawa-Hewlett-Packard Ltd.
- 101. Ricoh Company Ltd.
- 102. Rolandy G Co., Ltd.
- 103. YE Data Co,.
- 104. Wakom Co,.

